



Nuclear Physics Division  
*Data Acquisition Group*

## **Description and Technical Information for the PCI\_express Trigger Interface (TIpctie) Module**

William Gu ([jgu@jlab.org](mailto:jgu@jlab.org))

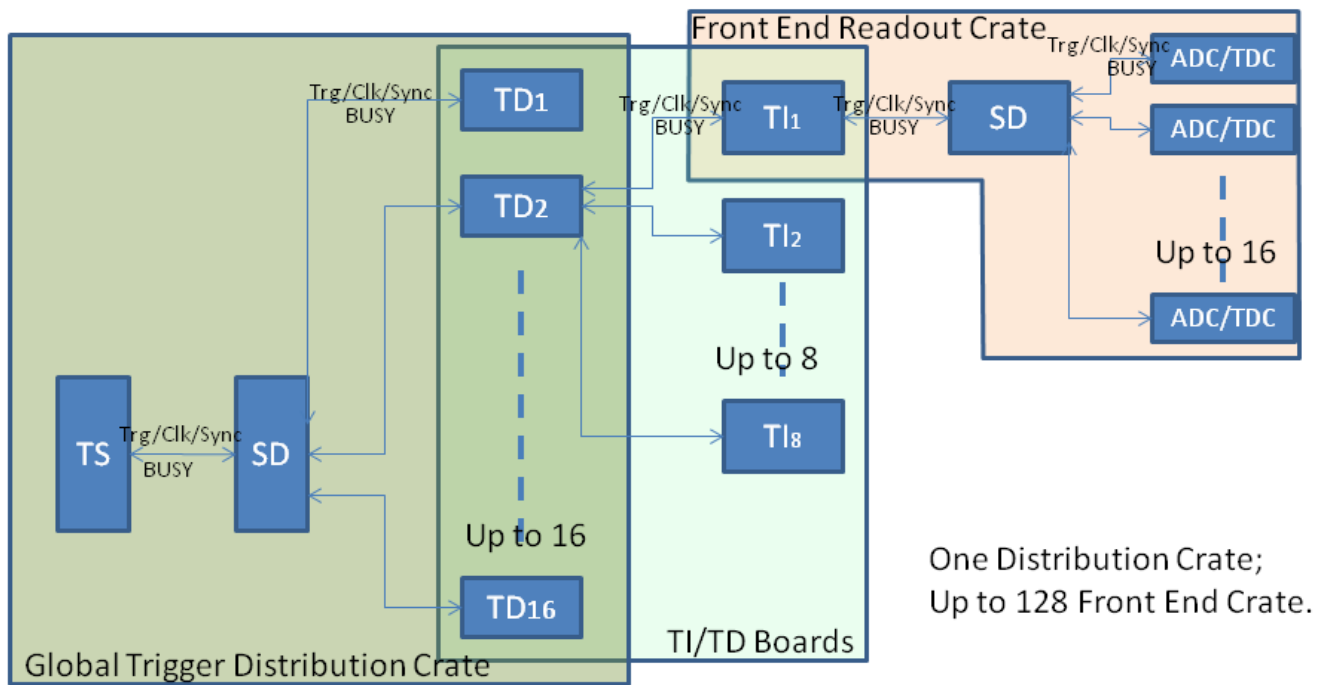
Updated: June 14, 2016

## Table of Contents

<b>Section</b>	<b>Title</b>	<b>Page</b>
1	Introduction	3
2	Purpose of TI Module	3
3	Function Description	4
4	Specifications	10
5	TI operation	11
6	Programming Requirements	12
7	VXS P0 and VME P2 Row-C Pin outs	21
8	Examples of individual test	22
9	Citation	23
Appendix A	Schematics	24
Appendix B	Fabrication Drawing	32
Appendix C	Bill of Materials	33
Appendix D	Glossary	35
Appendix E	TI data format	36
Appendix F	Revision history	38

# 1 Introduction

The Trigger Interface (TI) module is being designed for the Jefferson Lab 12GeV upgrade, mainly for HallD [ (Collaboration G. , 2009)] and Hall-B [ (Collaboration C. , 2009)], with other experimental Halls [ (experiments, 1990)] compatibility. The VXS TI boards are located in data acquisition frontend crates, and are responsible for providing a low-jitter system clock, sync signals and fixed latency trigger signals for the Front-end readout boards in the crates. The modules also merge the front-end crate status and generate a BUSY signal to request the Trigger Supervisor (TS) to pause the trigger. For the detailed description, refer to the Trigger Distribution system design document [Trigger Distribution]. The PCIexpress TI (TIpcie) board is based on the VXS TI board. Instead of VME64x, the TIpcie will be plugged into a PCIexpress slot in a computer, communicates through PCIexpress. Figure 1 shows the placement of the TI modules in the global trigger distribution scheme in experiment setup.

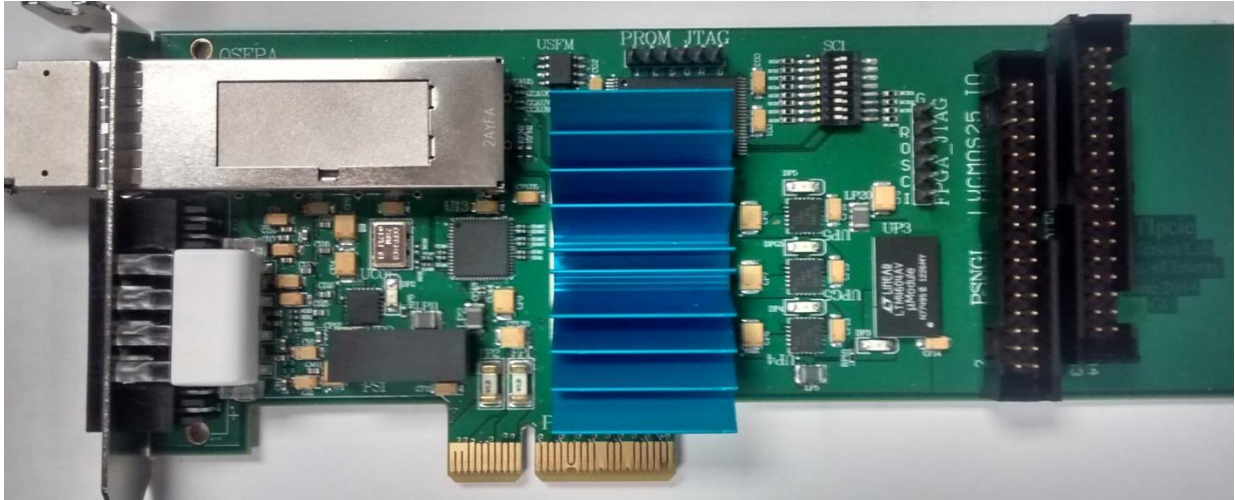


**Figure 1 Trigger/Clock/Sync distribution system**

The TIpcie board has simple Trigger Supervisor (TS) functions built in. The TIpcie can act as a trigger supervisor when used independently. The TIpcie board can be used in master mode and distributes Trigger/Clock/Sync to another TI board. The TIpcie also has the flexibility to select the trigger and clock inputs from central trigger system (used in slave mode) or onboard oscillator and loopback(used in master mode).

## 2 Purpose of the module

TIpcie board can be plugged in any PCIexpress x4 compatible slots. It can connect to a Trigger Distribution (TD) module in the global trigger distribution crate, sit in standalone mode, or drive another TI board as a master. This is done using a four channels full-duplex fiber link, which provides a gigabit trigger link, 250MHz clock and synchronization link to phase lock the trigger and initialize the system. The trigger link uses a reference clock derived from the 250MHz pipeline clock allowing a trigger word to be distributed every 4 global pipeline clock cycles. Figure 2 is a picture of the TIpcie board with a low profile bracket.



**Figure 2 TIpcie PCB picture**

The TIpcie can also perform simple Trigger Supervisor functions, as a TI Master (TM). In this case, it can take inputs from its front panel and generate trigger/clock like TS, and it can send the trigger, clock and SYNC to the front panel fibers like a TD.

The TIpcie FPGA firmware is compatible with the master mode and the standard mode. The firmware senses the TI clock setting. If the TIpcie clock source is set to onboard oscillator input, the TIpcie is in TM mode, or else, the TI is in standard mode. For the TM mode, the TRG/SYNC used in the TM is similar to the TRG/SYNC sent in the optical transceiver. The TRG/SYN is looped back within the FPGA and decoded the same way as a standard TI board. Some registers are valid on the TM only, as these registers are specific to the TS function. The TM can be used by itself in the setup. It can also drive another TI (or TIpcie) if the setup needs be expanded.

The TIpcie has a generic 16-channel LVDS input/output connector and a 32-channel LVCMOS/LVTTL input/output connector. One can directly connect two 34-pin cables to these connectors, or have a mezz card as a cable adaptor to connect to these two connectors. The advantage of the mezz card is that the mezz card can hold an fan to actively cool the TIpcie board, and one 3M P50E-068P1-SR1 connector can be used for better appearance (neat and convenient inside the computer). With the mezz board, the TIpcie looks like a double width card. One application of the generic 48-channel IO could be a high precision TDC.

## **3 Functional Descriptions**

### **3.1 General description**

Figure 2 shows the block diagram of the TIpcie module, indicating the major components used in the design. The AFBR-79EIDZ is the multi-channel (4 Rx, 4 Tx) fiber link that the TI fans out/receives a low-jitter (<3ps RMS) 250MHz global pipeline clock, serialized 16bit trigger words, and a sync signal used in producing a synchronized trigger. The AD9510 is the main clock driver and gets synchronized lower frequency clocks. The Xilinx XC5VLX30T is used to encode/decode the trigger words at 16ns, to interface with the computer PCIe/express bridge/root master.

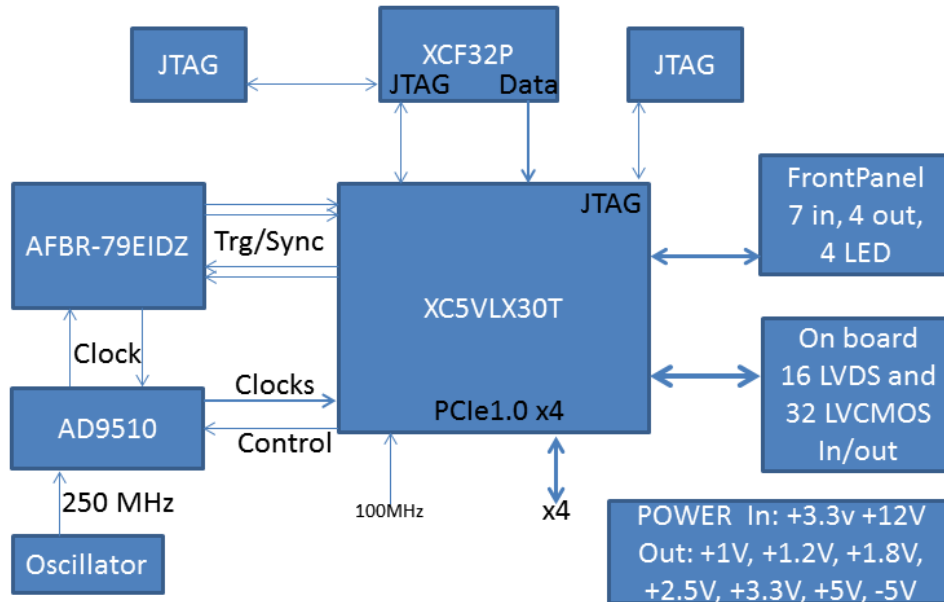


Figure 3 TIpcie block diagram

### 3.2 Fiber links

The AFBR-79EIDZ is the multi-channel (4 Rx, 4 Tx) fiber optic link for the TIpcie. The AFBR-79EIDZ has the same optic interface to replace the optic transceivers HFBR-7924 used on VXS TI and TD boards. When the TIpcie is in standalone mode, the optic transceiver is not used.

When the TIpcie is in standard (slave) mode, The first pair (Tx/Rx) is used to transfer trigger words from TD to TIpcie, and status from TIpcie to TD. The second pair is used to transmit the 250MHz clock from TD to TIpcie. The third pair is used to transmit the SYNC from TD to TIpcie. The TIpcie to TD links on second pair and third pair are not used.

When the TIpcie is in master mode, The first pair (Tx/Rx) is used to transfer trigger words from TIpcie to another TI, and the status from TI to TIpcie. The second pair is used to transmit the 250MHz clock from TIpcie to TI. The third pair is used to transmit the SYNC from TIpcie to TI. The TI to TIpcie links on second pair and third pair are not used.

The fourth pair (Tx/Rx) is looped back on the TIpcie when the the TIpcie is in master mode. Otherwise, the pair is used to send the FPGA generated pulse and receive the loopback (from TD) to measure the fiber latency.

### 3.3: Clock Distribution

One of the TIpcie's major functions is the pipeline clock distribution. There are two possible sources for the 250MHz clock: 'onboard oscillator' and 'optical fiber input from TD/TS'. When the TIpcie is in master mode, or standalone mode, the on board oscillator will be used, or else the optic fiber input will be used. There will be only one 250MHz clock running on the TIpcie. The clock source is selected by the FPGA using AD9510 clock driver, which also generate slower clocks (31.25MHz, 62.5 MHz, and 125 MHz).

### 3.4 Trigger distribution:

When the TIpcie is in master mode (or standalone mode), it can takes the trigger from the front panel inputs and do a quick lookup table and form a trigger word. It can also combine with the software trigger (which

includes periodic trigger up to 7 MHz (from ~16 Hz) and random trigger up to 466 KHz (from ~15Hz) and send to the MGT serialized mode (encoded) to the fiber. The trigger word is looped back to trigger the TIpcie itself.

When the TIpcie is in standard (slave) mode, it receives the trigger signal through the AFBR optical fiber and decoded by the FPGA. The trigger is used to generate TIpcie event data which includes the event type, trigger time stamp, and event number.

### 3.5: Encoded Trigger Word

A 1.25Gbps serial link operating over the fiber is used for distributing a 16bit trigger word every 16ns. There is also a link going in the opposite direction, allowing status words to be sent back to the trigger distribution crate. The 16bit trigger words are decoded as follows (TS → TD → TIpcie, or TImaster → TIslave):

Trigger strobe word – generated by the TS (or TIpcie in master mode) in response to the acceptance of a level 1 trigger. Upon receipt, the TIpcie aligns the trigger and start to assemble trigger event. The TS transmits these with fixed latency relative to the accepted trigger. This word is distributed every 16ns, so the trigger is distributed every 16ns. The timing information is added in the trigger word to distinguish which quadrant of the 16 ns period the trigger is generated to be fully compatible with the 4ns pipeline design architecture.

Trigger content word – additional information about the trigger for use by the ROCs. It is queued in a FIFO and sent in any frame not used by a trigger strobe word. So far, the trigger content words has not been used.

Control Word – request status, or other command (VME trigger for example). They can be queued in a FIFO and sent in any frame not used by a trigger strobe word or trigger content word.

Master Time Word – to fully use the trigger link, bits [13:2] of the TS time is transmitted whenever no other word types are available. By continuously receiving bits [13:2] of the TS time, each TI(pcie) can promptly detect if its frontend crate has lost global synchronization (i.e. compare the global time with its own time). Otherwise, the loss of synchronization could only be detected at the event building stage. The continuous transmission of ‘known’ (i.e. predictable) data also allows one to monitor the integrity of the link.

This table shows the format of the trigger word.

Bit(15:14)	Bit(13:12)	Word Type	Bit(11:10)	Bit(9:8)	Bit(7:0)
0 1	0 0	Time	Lower 12 bits of TS time		
0 1	0 1	Control	Control or Command		
0 1	1 0	Trigger Strobe	quadrant	Type	Event type
0 1	1 1	Trigger Content	Additional Trigger data		
1 0	0 1	GTP trigger	Quadrant	Type	Event type
1 0	1 0	FP trigger	Quadrant	Type	Event type
1 0	1 1	TS partition	TS4(2:0)	TS3(2:0)	TS2(2:0)   TS1(2:0)

- Bit(9:8) Type: 01: Trigger1, 10: Trigger2, 11: Sync trigger, 00: no trigger;
- TS partition trigger: TSn(2:0), 000: no trigger;

The data coming back to the TImaster or TD is defined into two categories. The first category is the status and acknowledgements. The second category is the register data. The first category has higher priority than the second category.

The following defines the data format for the opposite direction of the link (TIpcie → TD, or TI → TImaster flow):

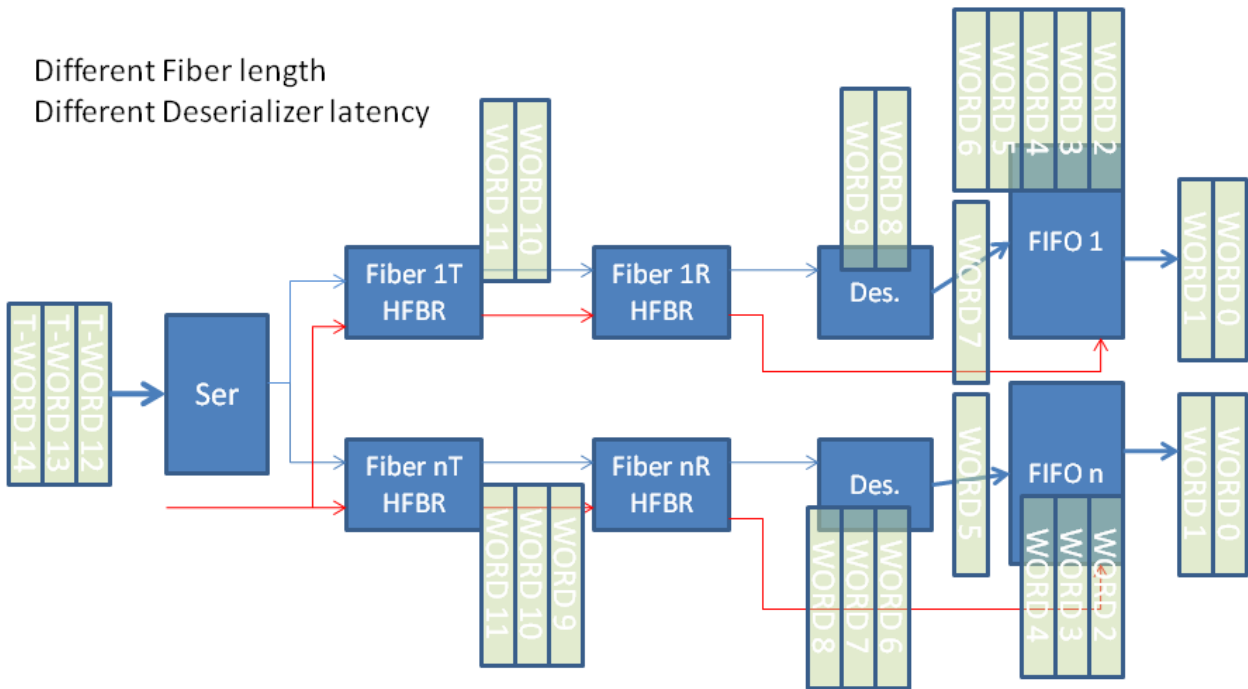
Bit(15:14)	Bit(13:12)	Word Type	Bit(11:8)				Bit(7:0)					
Parity	0 1	Ack/Busy	Busy	Trg Ack	Sync RstReq	#Sync RstReq	Busy	Trg1 Ack	Trg2 Ack	Blk Rcvd	Blk Ack	xxx
“0 0” or “1 1”	1 0	Register	0 0 1 0				Crate ID (7:0)					
			0 1 0		Board Ready		Trigger Source (7:0)					
			0 1 1		0		NewBlockSize					

### 3.6: Fixed Latency SYNC

The SYNC signal is a 250Mbps serial line operating in synchronous mode. This serial link allows a 4-bit command to be sent at chosen 4ns points in time. SYNC is synchronized to a slower clock (250/24 MHz) derived from the 250 MHz master clock and is sampled every 4 ns. The line is considered to be idle when more than 4 samples in a row are read ‘1’. A command is sent between idle times by sending first a ‘0’ followed by the 4bits that comprise the command, LSB first. After the command has been sent, a final ‘1’ is sent so that the line will return to the IDLE state. The encoding portion of this serial protocol is performed on the TS (or the TS function of the TImaster). Since the TD distributes this serial line over the fiber module, additional encoding (Manchester) is performed to balance the 1’s and 0’s of the line and to keep the maximum run length of the signal below the requirements of the fiber module. The TID decodes the SYNC signal (Manchester and command). Careful design in minimizing SYNC to the distributed master CLK250 skew guarantees a fixed latency link.

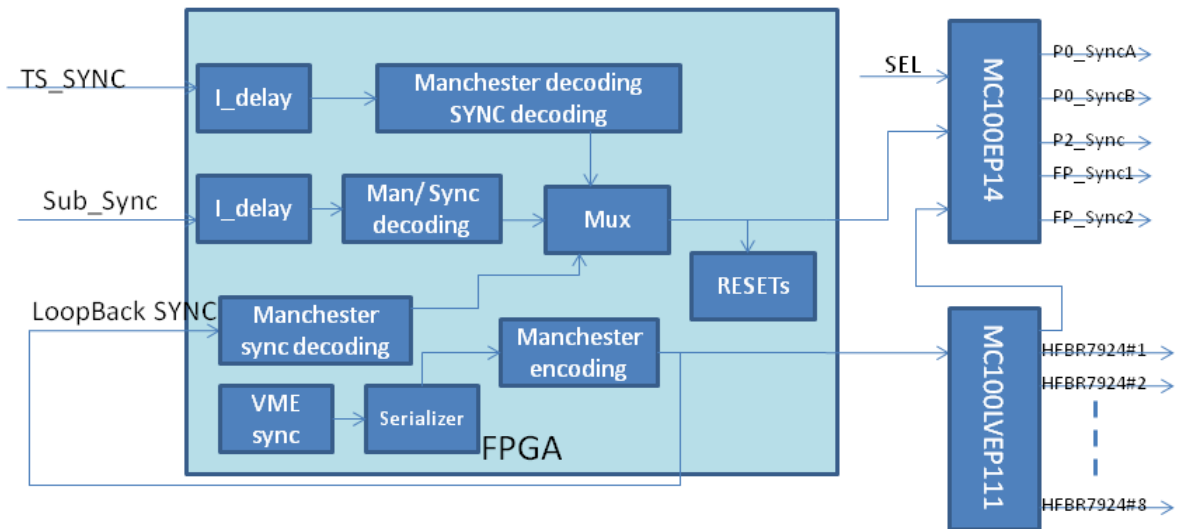
The SYNC is fiber delay adjusted on each TI. The fiber latency is measured using the fourth pair of the fiber. The SYNC is delayed so that all the TI modules will execute the SYNC command at exactly the same time (within the skew of the global 250MHz clock distribution).

The SYNC link is used in conjunction with a synchronous FIFO to enforce a fixed latency on the serial trigger link. The TD uses LVPECL buffers to fan out the trigger signal and the Sync signal, which is encoded (Manchester encoding) in the FPGA, to the HFBR\_7924 transceivers. In the TIpcie, the trigger word is clocked into a FIFO using the FPGA built in MGT transceivers and clocked out of the FIFO using a 62.5MHz clock derived from (and in phase with) the 250 MHz system clock. At startup, the FIFO is reset (0 words) and reading the FIFO is disabled. No words are written into the FIFO since the TS is not yet transmitting data words on the trigger link (i.e. received data valid signal is not asserted). Acceptance of triggers by the TS is also disabled. The TS starts transmission (time words) on the trigger link, and after a fixed number of 62.5MHz clock cycles issues a trigger start command on the SYNC line. In response to the trigger start command, the TI enables continuous readout of the FIFO. There must always be a non-zero number of words in the FIFO to maintain a fixed latency link. This will be true if the number of words pre-filled into the FIFO x 16 ns is greater than the latency uncertainty of the link. In the case of the MGT, several words (e.g. 3 or 4) are enough when the latency is set to minimum, as the elastic buffer is not necessary as all the clocks are the same or derived from the same 250MHz clock (no clock frequency difference). The TS must always be transmitting valid data to maintain the fixed latency of the link. This is illustrated in figure 4:



**Figure 4** Illustration of the trigger synchronization process

The SYNC link is also useful in ensuring that the lower frequency clocks derived in the TI from the distributed system clock (CLK250) have the same phase across all TI modules in the front-end data acquisition system. At startup, the TS issues a SYNC command CLKRESET. This resets the clock distribution chip (AD9510) in each TI(pcie) on the same CLK250 edge, assuring that the lower frequency clocks (125MHz, 62.5MHz, 41.67MHz and 31.25MHz) are in phase across the entire system. This command is sent before the TI sync command. The delay between them is determined by the maximum MGT reset recovery time, as the MGT clock is changed (AD9510 clock reset) during clock reset. The time is several milliseconds.



**Figure 5** The block diagram of the SYNC distribution on the TI board. On TIpcie, there is no MC100EP14 buffers, nor Sub\_sync input.



### 3.7 PCI express interface

The TIpcie board is a PCI express endpoint device. It is capable of PCIe 1.0 x4 (2.5 Gbps, 4 lanes). It is compatible with PCI express x4 or wider physical connector, though it is compatible with PCI express x1 connection.

The TIpcie has two 32-bit BA spaces. The BA#0 has 512 bytes, and it is compatible with regular TI VME setting registers. The BA#2 has 4 kBytes, which is for two JTAG engines, one for the FPGA and the other for PROM. The TIpcie trigger data can be readout word by word (32-bit) through a BA#0 memory word. The data can also be written to the computer memory via DMA.

The TIpcie support MSI for interrupt.

### 3.8: The Xilinx PROM programming.

The Xilinx XCF32P PROM is used to program the FPGA. It can save two different versions of the FPGA (XC5VLX30T) firmware when used in non-compression mode. The PROM can be programmed through the on-board JTAG connector. It can also be programmed by the PCI express directly (remotely) via the FPGA translation (FPGA PCI express to JTAG engine). One 50 MHz on-board oscillator is used to program the FPGA in slave mode. In slave SelectMAP (default, the PROM is in master mode) mode, the FPGA can be loaded in less than 30 ms.

### 3.9 Other functions

The TIpcie has a generic differential connector with four outputs and 7 inputs. This can be designed as regular TI compatible input/outputs. It also has two 34-pin connectors on board, which further expand the TIpcie IO capability.

### 3.10: Readout Synchronization

In addition to the event number and trigger time stamp, the readout can be forced to get synchronized by synchronization events (SyncEvent). There are two ways to generate the SyncEvent.

First, the SyncEvent can be generated periodically by TS (or TImaster). The last event of the every N blocks is generated as the SyncEvent. (for now, the block level, or number of event per block, is up to 255) The N is any value between 1 and 65535, which is set and enabled by A24 register offset 0xD4. When the periodic SyncEvent is marked, the original event type is kept.

Second, the SyncEvent can be forced by VME command to the TS (or PCI express to the TIpcie if the TIpcie is in master mode or standalone mode). This event may be any event in the trigger block. It is an added event with event type "00000000". The forced SyncEvent can be generated by VME A24 register offset 0x100 (or PCI express BA#0 memory byte space 0x100), bit#20. It is also possible that the SyncEvent is generated by a front panel signal input.

The TS (or TImaster) will assert a short BUSY (3us) after generating the SyncEvent, and stop further triggers. After receiving the SyncEvent, the TI(pcie) will generate BUSY, and set the SyncEvent marker in the ROC polling register offset 0x34. The BUSY of TI(pcie) will propagate back to the TD through fibers (and P0 backplane). The latency of this should be less than 3us, so that it will overlap with the short BUSY on TS. After the front end data is cleared, and the Readout acknowledge will clear the BUSY on the TI(pcie). In pipeline readout mode, if there are more than one trigger blocks to be read out, the very last acknowledgement clears the SyncEvent BUSY on the TI(pcie). After all the TI(pcie) boards clear their BUSY, the TS will distribute trigger again. Depending on the data acquisition mode and the amount of data backed up on the frontend, this process may take tens of microseconds to many milliseconds.

Upon SyncEvent, the trigger distribution will be paused. Users can change the DAQ settings during this time. If no reset in this time period, the event number and trigger time will be continued.

## 4. Specification Sheet

### 4.1 Mechanical

- Single width low profile PCI express 1.0 4x module. It will be positioned in any PCI express x4 compatible slot.

### 4.2 PCI express:

- PCI express 1.0 4x compatible, that is 4 lanes with 2.5 Gbps full duplex;
- Reference Clock at 100 MHz;
- JTAG on PCI express slot is not used, as most computers do not support (supply) JTAG;

### 4.3 Onboard connectors:

- 32-channels of LVTTTL or LVCMOS either input or output depending on the FPGA configuration.
- 16-channels LVDS input or output depending on the FPGA configuration.

### 4.4 Front panel inputs and outputs:

- 7-channels Any (differential) level inputs for trigger
- 3-channel ECL output
- 1-channel 2.5V LVPECL Output

### 4.5 Fiber channel signals:

- SYNC Fixed Latency Link
  - 250Mbps Serial Communication
  - Manchester Encoded
  - SYNC to CLK skew variation adjusted at FPGA receiver.
- TRIGLINKTX/TRIGLINKRX
  - 1.25Gbps Trigger Word Line
  - Provides 16bit parallel data every 16ns
  - A BUSY status word in the opposite direction.
- CLK
  - 250MHz Clock <3ps RMS Jitter

### 4.6 LED Indicators: Front Panel:

- Bit 1: (farther away from the motherboard) FPGA programmed and the clock (DCM locked) is ready;
- Bit 2: PCI express activity
- Bit 3: Trigger\_1 is sent out / received;
- Bit 4: AFBR optic transceiver Rx error;

#### On board:

- Power OK near each regulator or DC-DC converter (LED is OFF when the power is OK);
- FPGA program DONE (LED is OFF when programmed);

### 4.7 Programming:

- PCI express to JTAG engine using BA#1 for remote loading with redundant On board JTAG connector;
- Two revisions of the firmware can be stored in the PROM simultaneously, selected by an on-board switch.

### 4.8 Power requirements:

- +3.3V @ 3 Amps; +12V @ 0.25 Amp; (From PCI express connector)
- Local regulators for other required voltages: +1.0V, +1.2V, +1.8V, +2.5V, +3.3V, +5V and -5V.

#### **4.9 Environment:**

- Well ventilated desktop computers;
- Commercial grade components ( 0-75 Celsius)

### **5 TIpcie operation procedures:**

The TIpcie needs be properly set, and plugged into the PCI express slot. Damage may happen to the TIpcie, computer, or other components in the computer if the right procedure is not followed.

#### **5.1 TIpcie Power supply:**

The TIpcie uses +3.3V and +12V from the PCI express connector. It generate its own +5V, -5V supply by a DC-DC converter from +12V. It generates +1.8V by a DC-DC converter. It generates +1.0V, +1.2V +2.5V supplies by LDO linear regulators.

#### **5.2 Hardware setting (Switch etc.):**

There is one 8-bit switches on the TIpcie marked as SC1. This switch is used to set the FPGA firmware revision, the sources of the four front panel outputs.

Bit[2:1]: LVTTL, open=high. Firmware revision selection. When Bit2=0&Bit1=0, select firmware Rev0; when Bit2=0&Bit1=1, select firmware Rev1; when Bit2=1&bit1=0, select firmware Rev2; when Bit2=1&Bit1=1, select firmware Rev3. If the program bits are not compressed, the PROM XCF32P can only fit two revisions of the firmware.

Bit[4:3]: LVTTL, open high. Source selection for the four differential outputs (one LVPECL2.5V, three ECL). When “00”, the outputs are controlled by software BR#0, offset 0x4C, bit(3:0).

Bit[7:5]: LVCMOS from FPGA, not used

Bit[8]: Connected to the RESET# on the PCI express slot.

#### **5.3 Software setting:**

After the board is properly set, and plugged in the right slot, some software setting needs be applied for the board to work.

##### **5.3.1 Computer boot process:**

The TIpcie card is recognized at the computer BIOS boot. During the boot process, the PCI express enumeration will set the proper working parameters to TIpcie configuration registers. If the FPGA firmware is reloaded after the computer boot, the configuration registers will be lost. In that case, the configuration registers needs be reloaded. The easiest way is to restart the computer without power cycle the computer.

##### **5.3.2 Driver loading:**

The TIpcie card is set as manufacture “D0E1”, for DOE lab), device “71E0” (TI pci Express). As superuser, the driver (pci\_skel.ko) can be reloaded ~jgu/new\_pti/linux\_driver/reload\_driver.sh.

##### **5.3.3 TIpcie setup:**

The TIpcie card needs be setup properly:

Main Clock selection: BR#0, offset 0x2C: 0x0 for onboard oscillator, 0x2 for fiber input;

SYNC source selection: BR#0, offset 0x24: 0x10 for loopback; 0x02 for fiber input

DMA setting: BR#0, offset 0x54: TLP packet format, Max packet size, DMA size, higher address;  
offset 0x58: 32-bit DMA physical address;  
Trigger source etc: BR#0, offset 0x20, offset 0x28, 0x18 etc.

### 5.3.4 Trigger table loading:

There is a 6-bit inputs, 8-bits output look up table built in the TIpcie(master). The six-bit inputs corresponds to the six front panel inputs (marked as TS#1, TS#2, ... TS#6). The eight-bit outputs defines the trigger/event type. The eight output bits are defined by the data (table) loaded.

The table (64 bytes) is loaded by sixteen 32-bit VME words (BR#0, offset 0x1C0 – 0x1FC)

## 6. PCI express Programming Requirements (This part will be updated as the firmware develops)

There are three 32-bit Base Address are defined on the TIpcie card.

The BA#0 has 512 bytes addressable in 32-bit word only. These memory spaces are equivalent to the VME A24D32 registers on TI board.

The BA#1 has 4 kbyte addressable in 32-bit word only. These memory spaces are equivalent to the VME JTAG engine on TI board.

The BA#2 has 1 MB read only (in 32-bit word only). This is designed to read out the TIpcie event data in block read mode. Right now, the pci\_skel driver seems to send the single word read only, so this function is not used, nor the function has been debugged.

The default data readout process is the DMA write. When a readout data block is ready, the TIpcie will write the data to DMA as a ring buffer in 4kbyte blocks. The kernel can set 1MB to 4MB as DMA buffer in 32-bit addressing mode (the default, though the linux is 64-bit operating system).

### 6.1 BA#0 memory:

BA#0 memory spaces are used for register (VME A24D32 equivalent) read/write. They are addressed in 32-bit word only (not byte addressable, to be simple).

➤ Address offset: 0x00000: Board ID:

Bit 7-0 (R/W): Crate ID; Reset default 0x00;

Bit 13-8 (R): not defined yet;

Bit 15-14 (R): '10': TS is in running mode (no more register changes), others: TS not in running mode;

Bit 19-16 (R): PCB related setting, 0x1: production board, 0x0; prototype board;

Bit 31-20 (R): Board type: 0x71: TI, 0x75: TS, 0x7D: TD, 0x71E: TIpcie.

➤ Address offset: 0x00004: Optic transceiver I2C enable:

Bit 0 (R/W): AFBR optic transceiver I2C Enable, Reset default 0x1, disabled.

Bit 0: '0' enable AFBR#1 I2C, '1' disable AFBR#1 I2C; ('disable' means 'bypass in I2C')

Bit 31-16 (R): number of 64-bit word available in FIFO ready for PCI express DMA write.

➤ Address offset: 0x00008: Interrupt setting:

Bit 7-0 (R/W): Interrupt ID; Reset default 0xC8

Bit 10-8 (R/W): Interrupt level; Reset default 5;

Bit 16 (R/W): IRQ enable. Reset default: 0;

➤ Address offset: 0x0000C: Trigger delay and Pulse width:

Bit 7-0 (R/W): Trigger\_1 delay,  $(n+1)*4$  ns; Reset default 0x07;  
Bit 15-8 (R/W): Trigger\_1 Pulse width  $(n+1)*4$  ns; Reset default 0x07;  
Bit 23-16 (R/W): Trigger\_2 delay,  $(n+1)*4$  ns; Reset default 0x07;  
Bit 31-24 (R/W): Trigger\_2 Pulse width  $(n+1)*4$  ns. Reset default 0x07.

➤ Address offset: 0x00010 (R): DMA address:

Bit 31-22: DMA address;  
Bit 21-20: DMA address, determined by 1/2/4 Mbyte allocation;  
Bit 19-12: 4 KB block address;  
Bit 11-7: 128 Byte address;  
Bit 6-0: always '0', the minimum addressable block is 128 bytes.

➤ Address offset: 0x00014: Block size:

Bit 7-0 (R/W): Block size. Reset default 0x01; This is used on TD only. It's read/write register but does not affect anything in the FPGA.  
Bit 23-16 (R): Block size (block level). This is the block level used on the FPGA.  
Bit 31-24 (R): Block size set by TS (or TImaster). This is an intermediate value. The ROC should readout these eight bits, and set them to the other front DAQ electronics (FADC250, FADC125, etc).

➤ Address offset: 0x00018: TI data format control: Reset default 0011;

Bit 0: if '1', two block placeholder words are enabled; no longer used, default to no placeholder.  
Bit 3-1: Event format control:  
bit 1: '1' to enable the lower 32-bit trigger timing word;  
bit 2: '1' to enable the higher 16-bit of event number and higher 16-bit of trigger timing;  
bit 3: '1' to enable the front panel input bit pattern readout (before prescale).

➤ Address offset: 0x0001C: (Vme) PCIe setting:

Bit 21 (R/W): Enable instant block level update;  
Bit 22 (R/W): '1' to enable data to DMA, '0' to block (forbid) the data to DMA;  
Bit 23 (R/W): '1' to enable Interrupt, '0' to disable Interrupt to CPU;  
Bit 24 (W): '1' to set enable one data block to DMA. This is 'OR'ed with Bit 22.  
Bit 25 (R/W): '1' to enable auto PCIe Tx/Rx reset when the EOF is longer than 256 clock cycles (stuck); '0' to disable the auto reset.  
Bit (30:28) (R/W): when set to "101", the I2C is enabled for BAR1; otherwise, the JTAG is enabled for BAR1. The default is JTAG.  
Bit 31 (R/W): '1' to slow down the slow clock for Trigger\_rule by a factor of 32 (to get long trigger rule).

➤ Address offset: 0x00020: Trigger source register:

Bit 15-0 (R/W): Trigger source enables: Reset default 0x0000;  
Bit 1: AFBR optic transceiver trigger input;  
Bit 2: TImaster loopback trigger input;  
Bit 3: Front Panel trigger input;  
Bit 4: VME trigger;  
Bit 5: Front Panel Trigger Codes (as Supervisor) inputs;

Bit 7: Random Trigger.

Bit 11: Enable trigger2 to generate trigger1 (valid for TIpcie in master mode)

Bit 12: SubTS#1 trigger enable, this is valid on AFBR input only;

Bit 13: SubTS#2 trigger enable, this is valid on AFBR input only;

Bit 14: SubTS#3 trigger enable, this is valid on AFBR input only;

Bit 15: SubTS#4 trigger enable, this is valid on AFBR input only;

Bit 31-16 (R): Trigger source monitor.

➤ Address offset: 0x00024: Sync Source register:

Bit 15-0 (R/W): Sync Source enables: Reset default 0x02;

Bit 1: AFBR optic transceiver input;

Bit 4: Loopback SYNC enable, when TIpcie is in master or standalone mode;

Bit 6: automatic SyncReset enable

Bit 7: Enable the option for RESET to be set high (sync code 0x99), and low (sync code 0xcc).

Bit(11-8) (R): last SYNC code from AFBR;

Bit(19:16) (R): last SYNC code from loopback;

Bit(20) (R): SYNC history fifo empty;

Bit(21) (R): SYNC history fifo has more than 512 entries;

Bit(22) (R): SYNC history fifo full (reached 1024 entries);

Bit 31-24 (R): Sync source monitoring.

➤ Address offset: 0x00028: Busy source registers:

Bit 15-0 (R/W): Busy source enables:

Bit 0: '1' enable the Data busy (that is, when the data is ready to be readout (at least one block), set the TIpcie to busy.

Bit 2: '1' enable the TI\_Fifo\_Full busy. (that is, if the FIFO is full, it is BUSY)

Bit 4: '1' enable the front panel (bracket) busy input for TI\_BUSY to propagate to 'TS' for TS\_BUSY;

Bit 5: '1' enable the front panel (bracket) busy input for TS\_BUSY directly when in master mode;

Bit 6: '1' BUSY if the trigger is out, but the acknowledge (from slave TI) has not been received;

Bit 7: '1' enable TPpcie feed\_back BUSY, '0' disable the busy. (used in master or standalone mode)

Bit 8: AFBR BUSY enables: '1' enable the AFBR BUSY input, '0' disable;

Bit 31-16 (R): BUSY source monitoring.

Bit 22: 'trigger loss' for enabled (slave) TI(pcie).

➤ Address offset: 0x0002C: Clock source selection:

Bit 1-0 (R/W): software bit switch to control the clock source. Reset default 00;

Bit[1:0] = 00: oscillator clock;

Bit[1:0] = 10: AFBR clock input;

➤ Address offset: 0x00030: Trigger\_1 pre-scale:

Bit 15-0 (R/W): pre-scale factor:  $Rate = Rate\_0 / (Bit(15:0)+1)$ .

➤ Address offset: 0x00034: Trigger block inhibit:

Bit 7-0 (R/W): TIpcie trigger inhibit threshold (in the unit of event blocks); Reset default 0x01;

Bit 15-8 (R): Number of blocks in the DAQ ready to be readout.  
 Bit 23-16 (R): Number of events before a block is formed.  
 Bit 27-24 (R): Number of missing block acknowledge;  
 Bit 28 (R): if '1', the RUN is stopped because the block number (readout) has reached. (set by 0xFC)  
 Bit 29 (R): if '1', the event block is being filled by FillTrg;  
 Bit 30 (R): SyncReset Request set. If '1', SyncReset is required. To be issued by TImaster/TS.  
 Bit 31 (R): SyncEvent received, and the system is BUSY. Waiting for ROC to clear the frontend data.

➤ Address offset: 0x00038: Trigger rules:

Bit 7-0 (R/W): No more than 1 Trigger in (Bit(6:0)\*(16/160 ns)); Bit7 determines 16ns or 160ns step.  
 Reset default 0x03;  
 Bit 15-8 (R/W): no more than 2 trigger in (Bit(14:8)\*(16/320ns)); Bit15 determines 16ns or 320ns step.  
 Reset default 0x03;  
 Bit 23-16 (R/W): no more than 3 triggers in (Bit(22:16)\*(32/640 ns)); Bit23 determines 32ns or 640ns step.  
 Reset default 0x03;  
 Bit 31-24 (R/W): no more than 4 triggers in (Bit(30:24)\*(64/1280 ns)). Bit31 determines 64ns or 1280ns  
 step. Reset default 0x03;  
 The slower clocks can be even slowed down by a factor of 32 when the register 0x1c bit 31 is set to 1 !

➤ Address offset: 0x0003C: Trigger coincidence window:

Bit 7-0 (R/W): Trigger input coincidence window; Reset default 0x01;  
 Bit15-8 (R/W): Trigger inhibit window (extra to bit(7:0)). Reset default 0x00;  
 These two parameters are used to determine the event resolution  
 Bit24-16 (R/W): Set the delay between TRIGGER2 and the (TRIGGER2 generated) TRIGGER1. The  
 delay is in 4ns step with an offset (minimum setting) of ~2.6us;

➤ Address offset: 0x00044: Front panel generic trigger input enable:

Bit 5-0 (R/W): Front panel trigger code input enable (6 of the 7 input). Reset default 0x00.

➤ Address offset: 0x0004C: Blocks for VME interrupt:

Bit 3-0 (R/W): 4-bit output to the front panel generic output connector;  
 Bit 15-8 (R): Number of data blocks in the FIFO for readout;  
 Bit 23-16 (R): Number of data blocks ready for Interrupt Request;  
 Bit 31-24 (R): on TI: Number of events of a partial block (or, before the block is formed)

➤ Address offset: 0x00050: Sync delay setting (to compensate for the fiber length):

Bit 7-0 (R): on TI: SYNC phase of AFBR input;  
 Bit 15-8 (R/W): AFBR SYNC input delay; Reset default 0x00;  
 Bit 23-16 (R/W): TIpcie (internal loopback) SYNC delay; Reset default 0x00;

➤ Address offset: 0x00054: DMA setting:

Bit 15-0 (R/W): DMA physical address bit(47:32), used in 4-header TLP mode;  
 Bit 25-24 (R/W): DMA size, '01': 1048576 byte, '10': 2097152, '11': 4194304;  
 Bit 30-28 (R/W): TLP Maximum Packet Size. '001': 128 byte; '010': 256 byte; '100': 512 byte;

Bit 31 (R/W): DMA TLP address mode: '1': 64-bit/4 header mode; '0': 32-bit/3 header mode

- Address offset: 0x00058: DMA address setting:

Bit 31-0 (R/W): DMA lower 32-bit physical address.

- Address offset: 0x0005C: PCI express Configuration Link:

Bit 15-0 (R): PCI express Configuration Link Command: link control register from the PCI express extended capacity structure.

Bit 31-16 (R): Configuration Link Status: link status register from the PCI express extended capacity structure.

- Address offset: 0x060 (R): PCI express configure status:

Bit 0: Configuration To Turnoff: notify the user that a PME\_TURN\_OFF message has been received and the main power will soon be removed (negative logic).

Bit 1: Configuration Read Write Done (negative logic).

Bit 2: Configuration Error Completion Ready (negative logic)

Bit 3: Configuration Interrupt Ready (negative logic)

Bit 4: Configuration Interrupt MSI Enabled. Indicates that the Message Signalling Interrupt (MSI) messaging is enabled. If 0, then only legacy (INTx) interrupts can be sent.

Bit 12-5: Configuration Interrupt Data Out (7:0);

Bit 15-13: Configuration Interrupt Multiple Message Enable (2:0);

Bit 31-16: Configuration Completer ID (15:0)

- Address offset: 0x00064: Front Panel generic trigger input pre-scale: Reset default 0x00000000

Bit 3-0 (R/W): FP Generic trigger input #1;

Bit 7-4 (R/W): FP Generic trigger input #2;

Bit 11-8 (R/W): FP Generic trigger input #3;

Bit 15-12 (R/W): FP Generic trigger input #4;

Bit 19-16 (R/W): FP Generic trigger input #5;

Bit 23-20 (R/W): FP Generic trigger input #6;

- Address offset: 0x0006C (R): PCI express Configuration:

Bit 15-0: Configuration Command (15:0), command register from the configuration space header

Bit 31-16: Configuration Status(15:0), status register from the configuration space header.

- Address offset: 0x00070 (R): PCI express Device Configuration:

Bit 15-0: Configuration Device Command(15:0), Device control register from the PCI express extended capacity structure;

Bit 31-16: Configuration Device Status(15:0), Device status register from the PCI express extended capacity structure.

- Address offset: 0x00074 (R/W): Event type for some special event:

Bit 7-0: Multiple hits by GTP 'or' External trigger inputs (default 0xFA, for TS only)



Bit 15-8: Multiple hits by GTP ‘and’ External trigger inputs (default 0xFA, for TS only)

Bit 23-16: Software generated periodic trigger event type (default 0xFD);

Bit 31-24: Software generated random trigger event type (default 0xFE).

➤ Address offset: 0x00078: VME Sync Load

Bit 7-4 == Bit 3-0 (R/W): 4-bit sync code; Decoding of the Sync command (bit[7:0]):

0x11: PCI express clock DCM reset, and full reset; (do not use)

0x22: CLK250 resync (AD9510, DCM resync and MGT reset for trigger link);

0x33: AD9510 re-sync (slower clock phase adjustment), part of 0x22 functions;

0x44: Reset the MGT status\_B registers;

0x55: Trigger link enable (serial link started), FIFO read counter reset;

0x77: Trigger link disable, trigger FIFO write counter reset;

0xAA: reset the TIs slave trigger ready register;

0xBB: Reset the event number, and trigger input scalars (the 0xDD will not do);

0xDD: (SyncReset), FPGA logic and counter reset;

0x99: Force SyncReset high if this feature is enabled (by offset 0x24, bit 7);

0xCC: set the SyncReset low if it is forced high by code 0x99.

0xEE: generate an ~ 4us SyncReset signal.

0x66, 0x88: to be assigned;

0x00, 0xff: reserved, not to be assigned.

➤ Address offset: 0x0007C: VME Sync Delay. The latency before being serialized.

Bit 6-0 (R/W): latency, in 4ns steps. Reset default 000,0111

➤ Address offset: 0x00080: Reset pulse width: Reset default 00,0111

Bit 7-0 (R/W): Reset (generated by Sync code 0xdd) pulse width. Pulse width is  $(\text{Bit}(6:0) * (4/32 \text{ ns}))$ ,

Bit(7) determines the steps (4ns or 32ns);

➤ Address offset: 0x00084: software Trigger/Command Register

Bit 11-0 (R/W): Trigger Command code transmitted in the trigger link; In the 12 bits, 0xAABC, the 0xA determines the command type. For example:

Bit(11-0) = 0x123: (A=1) one trigger1 (readout trigger) pulse will be generated, and the event type = 0x23;

Bit(11-0) = 0x221: (A=2) one trigger2 pulse will be generated. The 0x21 is ignored;

Bit(11-0) = 0x812: (A=8) Set the block level (size), and the block level is set to 0x12.

➤ Address offset: 0x00088 (R/W): software Random Trigger Command Register:

Bit 3-0: Random trigger\_1 rates:  $466 \text{ KHz} / (2^{\text{Bit}(3:0)})$ ;

Bit 6-4: same as Bit(2-0) for redundancy check. No match, no trigger\_1;

Bit 7: enable/disable random trigger\_1; (There is NO requirement that it match with bit 3)

Bit 11-8: Random trigger\_2 rates:  $466 \text{ KHz} / (2^{\text{Bit}(11:8)})$ ;

Bit 14-12: same as Bit(10-8) for redundancy check. No match, no trigger\_2.

Bit 15: enable/disable random trigger\_2;

- Address offset: 0x0008C(R/W): software periodic Trigger Generation:
  - Bit 15-0: Number of trigger\_1 to be generated; if 0xFFFF, the number of event will not be limited.
  - Bit 31-16: (trigger rate control) Time between triggers.  $T = (32+8*\text{Bit}(30:16))*2048^{\text{Bit}(31)}$  ns. (Assuming that the PCI express reference clock is 100MHz, and the interface clock is 125 MHz or 8ns period. As the bit(17:16) is not used for higher frequency mode when Bit(31)=0, it might be better to write  $T = (32+4*8*\text{Bit}(30:18))*2048^{\text{Bit}(31)}$  ns)
- Address offset: 0x00090(R/W): VME Trigger\_2 Generation:
  - Bit 15-0: Number of trigger\_2s to be generated;
  - Bit 31-16: (trigger rate control) Time between triggers.  $T = (32+8*\text{Bit}(30:16))*2048^{\text{Bit}(31)}$  ns. (Assuming that the PCI express reference clock of 100 MHz, and the interface clock is 125 MHz or 8 ns period).
- Address offset: 0x00094 (R): Number of Blocks in the DAQ system:
  - Bit 31-24: Number of events before a full data block;
  - Bit 23-0: Number of full data blocks the TI has ever generated (since last reset or SyncEvt);
- Address offset: 0x00098 (R): SYNC history FIFO, The FIFO status is in register offset 0x24.
  - Bit 31-21: time stamp of the SYNC command, in steps of ~4us;
  - Bit(20): whether the time stamp has overflowed since previous SYNC code
  - Bit (19): TIpcie master generated sync code valid;
  - Bit (18:15): TIpcie master generated sync code;
  - Bit (14): Loopback sync valid;
  - Bit (13:10): Loopback sync code;
  - Bit (4): AFBR fiber sync valid;
  - Bit (3:0): AFBR fiber sync code;
- Address offset: 0x0009C (R/W): The FPGA running mode;
  - Bit 7-0: TS in running mode if set to 0x5A; if other value, not in running mode. Reset default 0x00; TI in running mode if set to 0x71. TI starts clock monitoring in 'running' mode.
- Address offset: 0x000A0 (R): Fiber latency measurement result:
  - Bit 31-23: latency data in 4ns steps
  - Bit 22-16: Delay in the IODelay, in  $5000/64=78.125$ ps steps
  - Bit 15:0: Delay in the carry chain, two bits per slice, (or two mux per bit)
- Address offset: 0x000A8 (R): Trigger live timer:
  - Bit 31-0 (r): board live time counter. The real time is  $\text{Bit}(31:0)*256*8$ ns. (Scalar Latch is required.)
- Address offset: 0x000AC (R): Trigger busy (trigger dead) timer:
  - Bit 31-0 (r): TI(pcie) busy (cannot accept trigger, or trigger dead) time counter. The real time is  $\text{Bit}(31:0)*256*8$ ns. This counter and the live time counter make up the total time counter, which is the total time since any one of the trigger sources is enabled.
- Address offset: 0x000B0 (R): MGT STATUS\_A:

Bit 0: Trigger Link (AFBR) MGT reset\_done;  
 Bit 5-4: Trigger link received Data Error;  
 Bit 7-6: Trigger link received data Not\_in\_table;  
 Bit 8: Trigger link MGT PLL lock detected;  
 Bit 15-13: PCI Express Link State (2:0): One-hot encoded bus that reports the PCI express link state to the user: 110 → PCI express link state is “L0”; 101 → PCI express link state is “L0s”; 011 → PCI express link state is “L1”; 111 → PCI express link state is “in transition”  
 Bit 23-16: trn\_rfc\_ph\_av(7:0): Receive Posted Header Flow Control Credits Available: the number of Posted Header FC credits available to the remote link partner.  
 Bit 31-24: trn\_rfc\_nph\_av(7:0): Receive Non-posted Header Flow Control Credit Available: Number of Non-posted Header FC Credits available to the remote link partner.

➤ Address offset: 0x000B4 (R): MGT STATUS\_B registers (not assigned on TIpcie):

Bit 7-0: Channel bonding sequence detected in MGT[7:0];  
 Bit 15-8: received data is not an 8B/10B character, or has disparity error in MGT[7:0];  
 Bit 23-16: RX disparity error has occurred in MGT[7:0];  
 Bit 31-24: Rx data not in 8B/10B table has occurred in MGT[7:0].

➤ Address offset: 0x000B8 (R): MGT trigger data buffer length:

Bit 9-0: Global trigger data buffer length (to be minimized to 0 for the longest fiber);  
 Bit 11-10: Data generation fifo full (in TRGDAQ module);  
 Bit 13-12: Data Readout fifo prog\_almost\_full (in VME module);  
 Bit 15:14: Data Readout fifo full; The order should be: DataReadoutFifoProgFull → DataGenFifoFull → DataReadoutFifoFull  
 Bit 25-16: Sub-system trigger data buffer length;  
 Bit 27: TI is in running mode if ‘1’;  
 Bit 28: HFBR#1 MGT receiver error;  
 Bit 29: CLK250 DCM locked;  
 Bit 30: Clk125 DCM locked;  
 Bit 31: PCI express interface CLK (125 MHz, not the 100 MHz reference) DCM locked

➤ Address offset: 0x000BC (R): TS input trigger counter:

Bit 31-0: Number of triggers received by TS (before BUSY inhibits).

➤ Address offset: 0x000C0 (R): valid for TIpcie in master mode:

Bit 7-0: Number of blocks to be readout on AFBR (blocks need ROCack);  
 Bit 15-8: Number of blocks is still missing on AFBR (blocks need TRGack);  
 Bit 23-16: Number of blocks to be readout on TIpcie itself (loopback);  
 Bit 31-24: Number of blocks is still missing on TIpcie itself (loopback);

➤ Address offset: 0x000D4 (R/W): Periodic Sync Event register

Bit 19-0: Number of data blocks to assert a sync event (periodic SyncEvent);  
 Bit 31-20: not used. When the Bit(19:0) is not zero, the Sync event is enabled.

- Address offset: 0x000D8 : Event number register
  - Bit 15-0 (R/W): Prompt Trigger Width, width = (bit(6:0) + 3) \* 4ns;
  - Bit 31-16: higher 16-bit (bit 47-32) of event number counter;
- Address offset: 0x000DC (R): Event number register
  - Bit 31-0: lower 32-bit (bit 31-0) of event number counter.
- Address offset: 0x000EC (R/W): ROC enable
  - Bit 7-0: ROC 8:1 enable, the default is 00000001
  - Bit 11-10: SyncResetRequest enable. This corresponds to the TI slaves (bit#11) and the loopback (bit#10).
  - Bit 21-20: Monitor of the SyncResetRequest corresponding to the bit#11:10.
- Address offset: 0x000F0 (R): valid for TM (or with TS function)
  - Bit 31-0: Number of valid code from Front Panel Async trigger inputs
- Address offset: 0x000FC (R/W): End\_of\_Run number of block setting
  - Bit 31-0: number of block to End the run. If this is set to 0, there is no limit (disabled).
  - Bit 0: Enable the front panel (external input) signal to latch the trigger input scalars;
  - Bit 1: Enable the front panel (same signal as controlled by bit0) to reset the trigger input scalars; **These two** bits are kind of related to the OneShotVme command, offset 0x100, bit 24 and bit25.
- Address offset: 0x00100 (W): Reset and one-shot registers. The signal will be one PCI express interface cycle. If the ClkPcie is 125 MHz, the one-shot will be 8ns wide. Positive logic.
  - Bit 0: not used;
  - Bit 1: if '1', reset the PCIe\_to\_I2C engine (not used);
  - Bit 2: if '1', RESET signal to reset the PCIe\_to\_JTAG engine;
  - Bit 3: if '1', RESET signal to reset the PCIe\_to\_SFM engine (not used);
  - Bit 4: if '1', RESET signal to reset the BR#0 registers (Tlpcie settings) to their default values;
  - Bit 6: if '1', reset the SYNC history FIFO (clear the FIFO);
  - Bit 7: if '1', this register will generate a BUSY reset, and ROC\_Ack pulse;
  - Bit 8: if '1', Reset the CLK250/Clk200 DCM.
  - Bit 9: if '1', Reset the CLK125 DCM.
  - Bit 10: if '1', Reset the trigger MGT (MultiGigabit Transceiver,) inside the FPGA.
  - Bit 11: if '1', Auto alignment of SYNC phase from AFBR fiber;
  - Bit 13: if '1', Auto alignment of fiber latency measurement signals;
  - Bit 14: if '1', Reset the IODELAY;
  - Bit 15: if '1', Measure the fiber latency
  - Bit 17: if '1', the available number of data blocks will decrease by 1 without real readout,
  - Bit 20: if '1', generate a SyncEvent (forced SyncEvent). This can be used as end\_of\_run etc.
  - Bit 21: if '1', clock reset for the ClkVme, and all other clocks (similar to Sync\_code 0x11), Be cautious.
  - Bit 22: if '1', MGT Rx\_CDR reset, which also includes RxReset.
  - Bit 23: if '1', generate Sync\_Reset\_Request.

Bit 24: if '1', all the trigger input scalars are latched (ready for read out), the BusyTimer (0xAC) and LiveTimer (0xA8) are also latched;

Bit 25: if '1', all the trigger input scalars are reset. (Bit 24 and Bit 25 can be set simultaneously). The event number is also reset by this.

Bit 31: if '1', the end\_of\_run command. If the readout block is not full, dummy trigger will be generated to fill the block.

- Address offset: 0x00104 (R/W): front panel input trigger (TS Code) delay (in 4 ns steps):

Bit 8-0: TScore#1 trigger input delay (Channel#1);

Bit 18-10: TScore#2 trigger input delay (Channel#2);

Bit 28-20: TScore#3 trigger input delay (Channel#3);

- Address offset: 0x00108 (R/W): front panel input trigger (TS Code) delay (in 4 ns steps):

Bit 8-0: TScore#4 trigger input delay (Channel#4);

Bit 18-10: TScore#5 trigger input delay (Channel#5);

Bit 28-20: TScore#6 trigger input delay (Channel#6);

- Address offset: 0x138 (R/W): Extra hold off after trigger rule (minimum busy width)

Bit 31: '1' to enable the minimum busy width for trigger rule#4;

Bit(30:24): Minimum busy width for rule#4.  $MinimumWidth = bit(30:24) * Tclock$ .  $Tclock = 480ns$  if bit#31 of Reg#1C is set to '0';  $Tclock = 480 * 32ns$  if bit#31 of Reg 0x1C is set to '1';

Bit 23: '1' to enable the minimum busy width for trigger rule#3;

Bit(22:16): Minimum busy width for rule#3.  $MinimumWidth = bit(22:16) * Tclock$ .  $Tclock = 480ns$  if bit#31 of Reg#1C is set to '0';  $Tclock = 480 * 32ns$  if bit#31 of Reg 0x1C is set to '1';

Bit 15: '1' to enable the minimum busy width for trigger rule#2;

Bit(14:8): Minimum busy width for rule#2.  $MinimumWidth = bit(14:8) * 16ns$ . The maximum width setting is ~2us.

Bit 7-0: Minimum busy width for trigger rule#1, not used, and no need for this.

- Address offset: 0x140 – 0x17C (W): Trigger table loading:

Bit 31-0: 32-bit wide table loading.

Address bits(5-2) are used to load 16 32-bit words;

- Address offset: 0x00180 (R): FP input trigger scalar for #1:

Bit 31-0: 32-bit scalar, number of input#1 counter

- Address offset: 0x00184 (R): FP input trigger scalar for #2:

Bit 31-0: 32-bit scalar, number of FP input#2 counter

- Address offset: 0x00188 (R): FP input trigger scalar for #3:

Bit 31-0: 32-bit scalar, number of FP input#3 counter

- Address offset: 0x0018C (R): FP input trigger scalar for #4:

Bit 31-0: 32-bit scalar, number of FP input#4 counter

- Address offset: 0x00190 (R): FP input trigger scalar for #5:
  - Bit 31-0: 32-bit scalar, number of FP input#5 counter
- Address offset: 0x00194 (R): FP input trigger scalar for #6:
  - Bit 31-0: 32-bit scalar, number of FP input#6 counter
- Address offset: 0x001D0 (R): optic transceiver AFBR TI ID (in master mode)
  - Bit 7-0: Trigger Source Enable of the TI connected to fiber;
  - Bit 15-8: Crate ID of the TI connected to fiber.
  - Bit 23-16: Block level set on TI connected to fiber.
- Address offset: 0x001F0 (R): The TI master (itself) ID (in master mode)
  - Bit 7-0: Trigger Source Enable of the TI itself, should be the same as bit7-0 of register 0x20;
  - Bit 15-8: Crate ID of the TI itself, should be the same as bit7-0 of register 0x00.

## 6.2 BAR#1 (PCI express to JTAG engine, PCIe to I2C engine):

- When the BAR0 register 0x1C bit (30:28) is anything but “101”, the BAR#1 is a PCIe to JTAG engine.
 

BAR#1 4 Kbyte spaces are used for PCI express to JTAG engines. The engines include: PCI express to JTAG engine for the FPGA and PCI express to JTAG engine for the PROM. Not all the 32 bits of data may be used. In that case, the lower N bits (specified by the address) are used.

Register offset Address(11:0): 0xXXX

Address Bit(11): JTAG engine selection, ‘1’ for PROM, ‘0’ for FPGA;

Address Bit(10:6): Number of bits to shift (Instruction register or Data register),  $n=A(10:6)+1$ , that is the minimum number of bits to shift is 1, and maximum number of bits to shift is 32, the lower order of bits in the 32-bit data are used.

Address Bit(5:4): Specific JTAG command. “01”: JTAG data register shift; “10”: JTAG instruction register shift; “11”: JTAG reset, (set the JTAG to RESET\_IDLE state).

Address Bit(3): JTAG TRAILER\_ENABLE. This will enable several extra JTAG clocks (after register shift) to move the JTAG state machine from register shift (either data register or instruction register) to RESET\_IDLE.

Address Bit(2): JTAG HEADER\_ENABLE. This will enable several extra JTAG clocks (before register shift) to move the JTAG state machine from RESET\_IDLE to register shift (either data register or instruction register depending on the shift type A(5:4))

Address Bit(1:0): “00” only.

The PCI express read to the device will return the data currently stored in the TDO shift register (32-bit). The read address is Address(11). Address(10:0) are DONOT care bits. 32-bit data read only
- When the BAR0 register 0x1C bit (30:28) are set as “101”, the BAR#1 is a PCIe to I2C engine.
 

BAR#1 4 Kbyte spaces are used for PCI express to I2C engines. PCIe A32 operation only.

Register offset Address(11:0): 0xXXX definition:

Address(11): Lowest bit of the device address, for Avago AFBR-79EIDZ, the address is “1010\_000”, that is this bit is set to ‘0’.

Address(10): ‘1’ for two bytes operation; ‘0’ for single byte operation.

Address(9:2): Eight bits of I2C (starting) byte address.

Address(1:0): always “00”.

The readout data is always 32-bit, but only the lower 8 bits (16 bits) are used for one bytes (two bytes) read and write. The PCI read data is the data in the engine register, so there is a one-read lag (behind).

## 6.4 PCI express data acquisition:

For data acquisition, the DMA data writes are used. The DMA physical address is set by the BR#0 register (0x54 and 0x58). The Tlpcie writes to the DMA as a ring buffer. The buffer unit is 4 Kbyte. For extra large events, two buffer units may be used ( when the block level is set to more than 240, and the event size is set to maximum).

## 7 Backplane pin out tables:

### 7.1 PCI express Pinout Table (copied from Wikipedia)

Pin	Side B	Side A	Description
1	+12 V	PRSENT1#	Must connect to farthest PRSENT2# pin
2	+12 V	+12 V	
3	+12 V	+12 V	
4	Ground	Ground	
5	SMCLK	TCK	
6	SMDAT	TDI	
7	Ground	TDO	<a href="#">SMBus</a> and <a href="#">JTAG</a> port pins
8	+3.3 V	TMS	
9	TRST#	+3.3 V	
10	+3.3 V aux	+3.3 V	<a href="#">Standby power</a>
11	WAKE#	PERST#	Link reactivation; fundamental reset
<b>Key notch</b>			
12	CLKREQ#	Ground	Request running clock
13	Ground	REFCLK+	Reference clock differential pair
14	HOp(0)	REFCLK-	Lane 0 transmit data, + and -
15	HOn(0)	Ground	
16	Ground	HSIp(0)	Lane 0 receive data, + and -
17	PRSENT2#	HSIn(0)	
18	Ground	Ground	
PCI Express ×1 cards end at pin 18			
19	HOp(1)	Reserved	Lane 1 transmit data, + and -
20	HOn(1)	Ground	
21	Ground	HSIp(1)	Lane 1 receive data, + and -
22	Ground	HSIn(1)	

23	HSOp(2)	Ground	Lane 2 transmit data, + and -
24	HSON(2)	Ground	
25	Ground	HSIp(2)	Lane 2 receive data, + and -
26	Ground	HSIn(2)	
27	HSOp(3)	Ground	Lane 3 transmit data, + and -
28	HSON(3)	Ground	
29	Ground	HSIp(3)	Lane 3 receive data, + and -
30	Reserved	HSIn(3)	
31	PRSNT2#	Ground	
32	Ground	Reserved	

### 7.3 Front panel (PCI express bracket) User-defined pin table

11 pairs of the 12-pair connector are used:

Pin name	Signal Name	Signal Level
Pin 1/2	Not used	NA
Pin 3+/4-	Output #1	ECL
Pin 5+/6-	Output #2	ECL
Pin 7+/8-	Output #3	ECL
Pin 9+/10-	Output #4	LVPECL25
Pin 11+/12-	Input, front panel BUSY in	Any level differential
Pin 13+/14-	Input TS#1	Any level differential
Pin 15+/16-	Input TS#2	Any level differential
Pin 17+/18-	Input TS#3	Any level differential
Pin 19+/20-	Input TS#4	Any level differential
Pin 21+/22-	Input TS#5	Any level differential
Pin 23+/24-	Input TS#6	Any level differential

### 7.4 JTAG connector pin table

6-pin connector pin definition, fly wire to Xilinx programmer (USBII):

Pin name	Signal Name	Signal Level
Pin 1	JTAG TDI	LVTTL
Pin 2	JTAG TCK	LVTTL
Pin 3	JTAG TMS	LVTTL
Pin 4	JAG TDO	LVTTL
Pin 5	Xilinx programmer Vref	2.5V
Pin 6	GND	0 V

## 8 TID Operation examples:

The following is some operating procedures on Dell T5500 machine.

```
GU_PC > cd ~/jgu/new_pti/linux_driver/
```

```
GU_PC > su
```



```
GU_PC > reload_driver.sh
```

```
GU_PC > cd ~/jgu/new_pti/test
```

### **8.1 BA#0 register (0x00) write/read operation:**

```
GU_PC > pti_test w 0 0x00 0xdadadada -- memory 0x00 write
```

```
GU_PC > pti_test r 0 0x00 -- memory 0x00 read
```

### **8.2 BA#1 access: Readout the FPGA user\_ID:**

The FPGA user code is readout through PCI express to JTAG engine by BA#1 memory.

```
GU_PC > pti_test w 1 0x 3c 0 -- reset the JTAG engine
```

```
GU_PC > pti_test w 1 0x26c 0x3c8 -- 10-bit instruction register
```

```
GU_PC > pti_test w 1 0x7dc 0 -- 32-bit data register
```

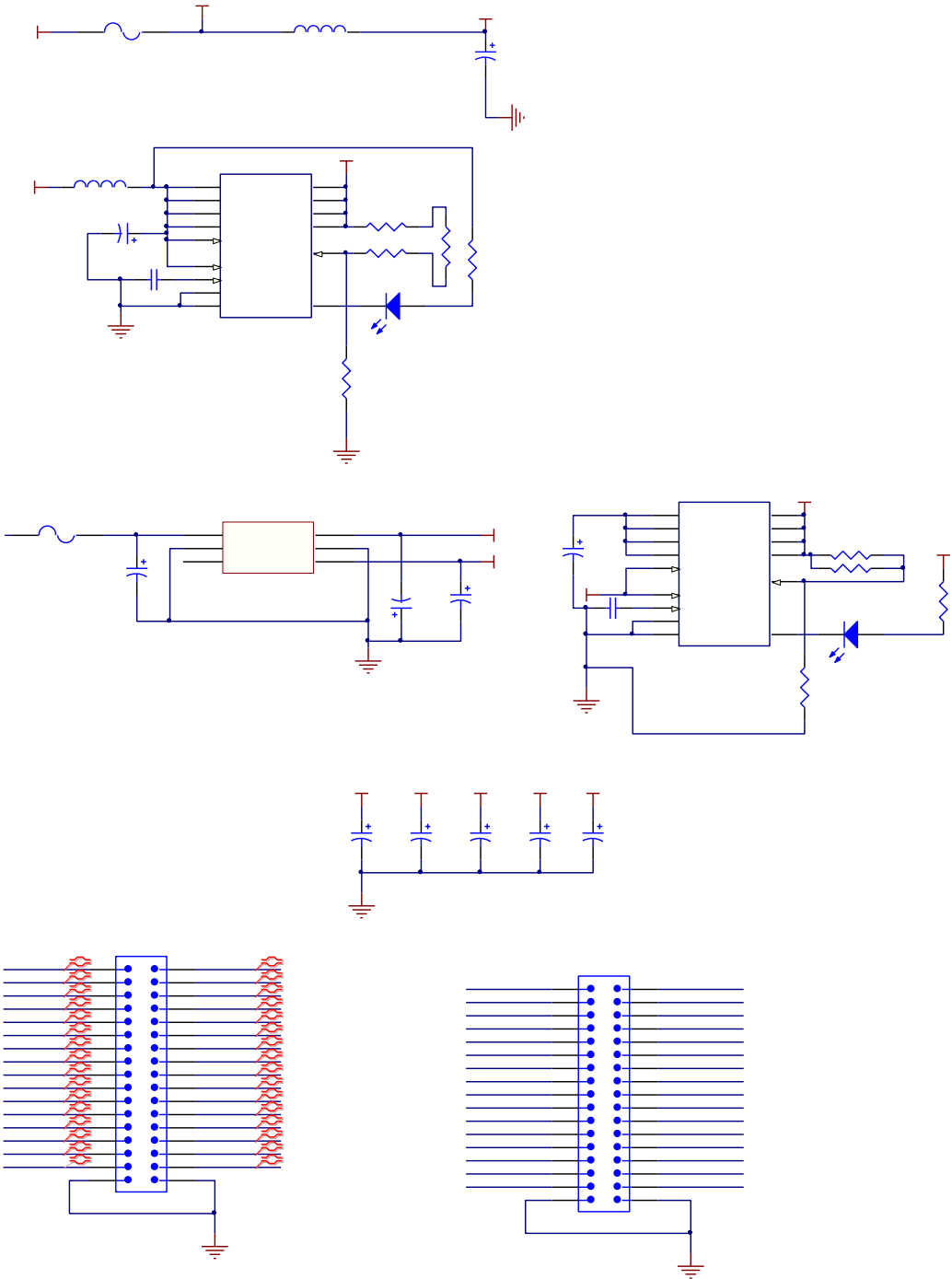
```
GU_PC > pti_test r 1 0x0 -- 32-bit data register read
```

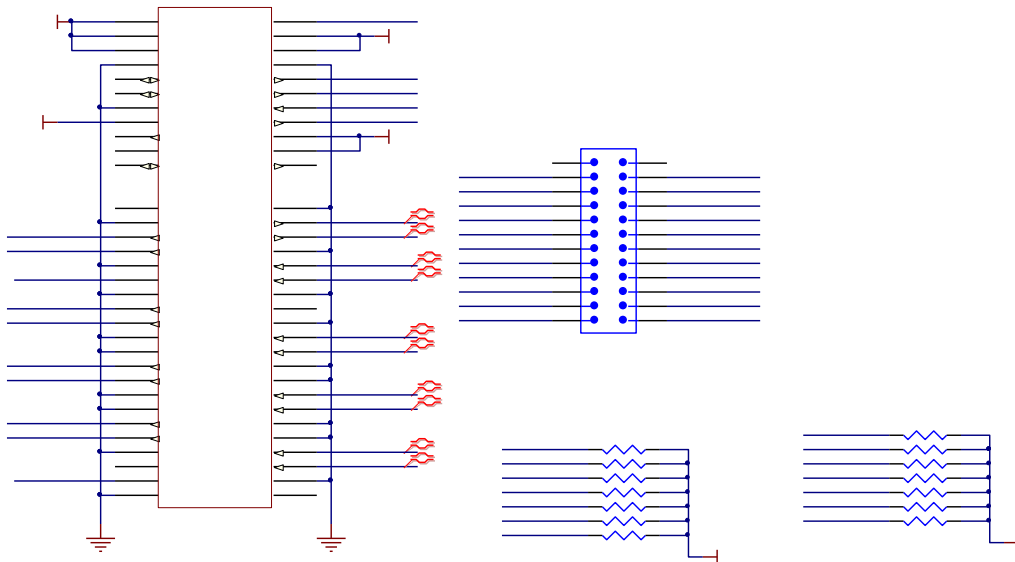
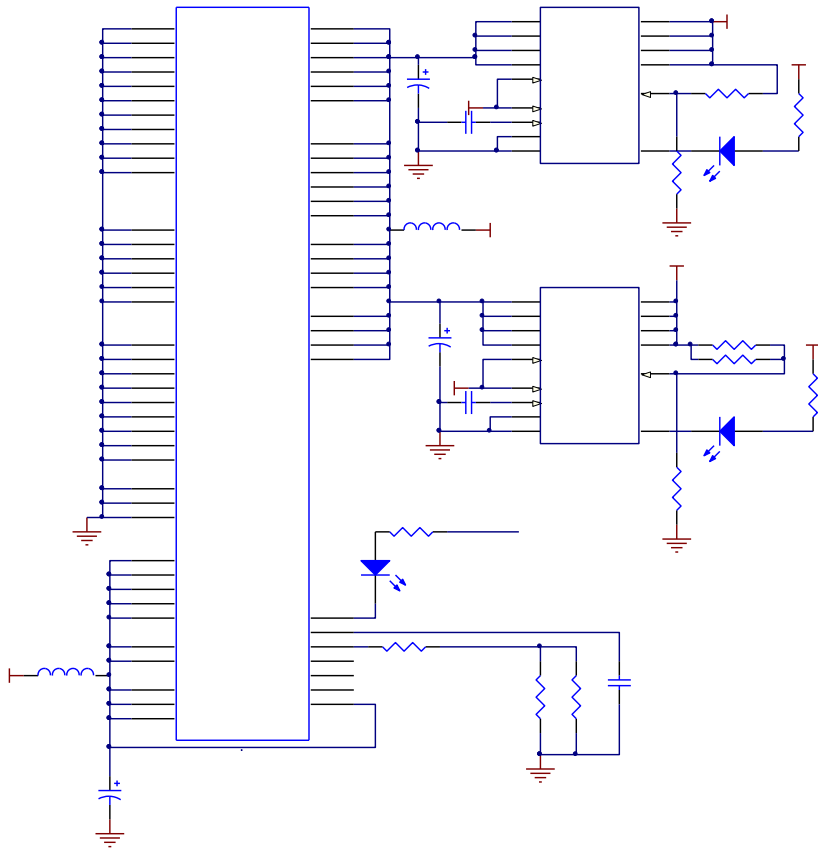
## **9. Citations:**

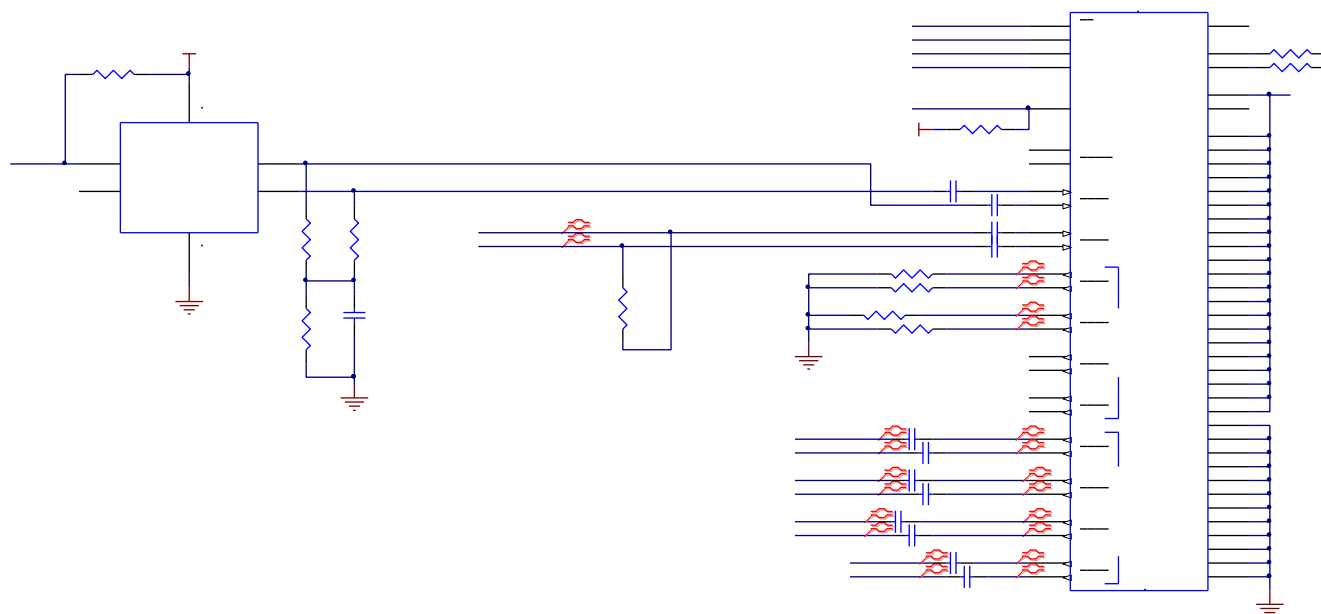
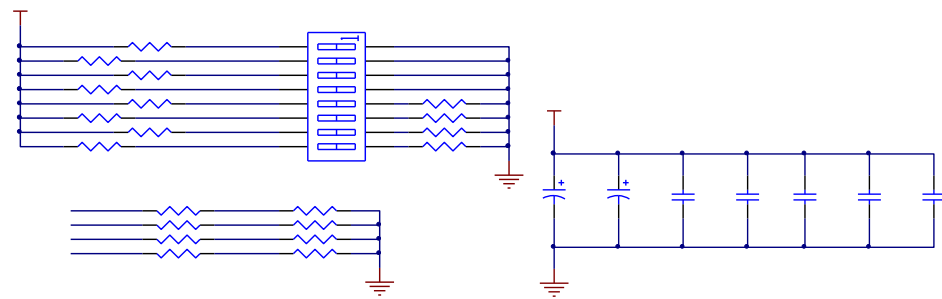
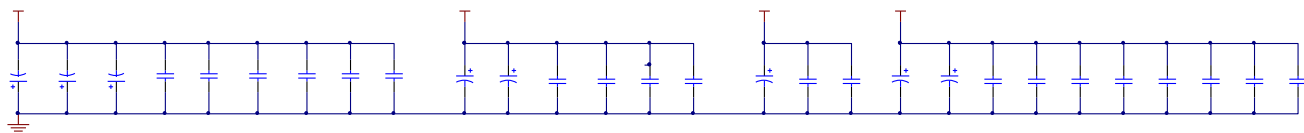
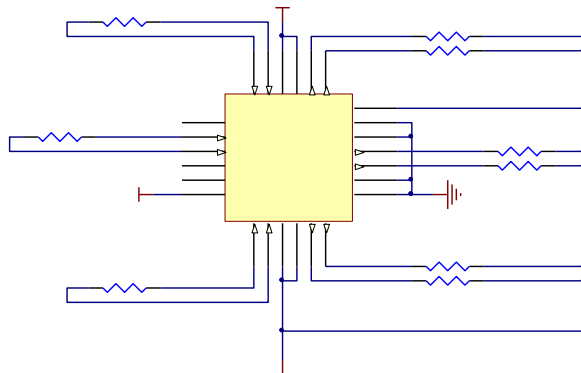
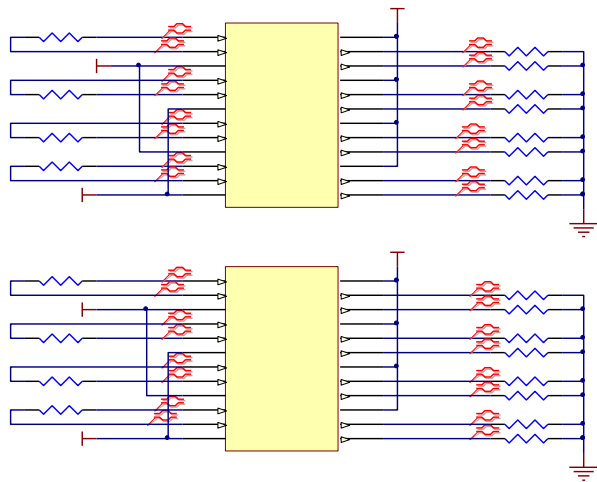
### **Works Cited**

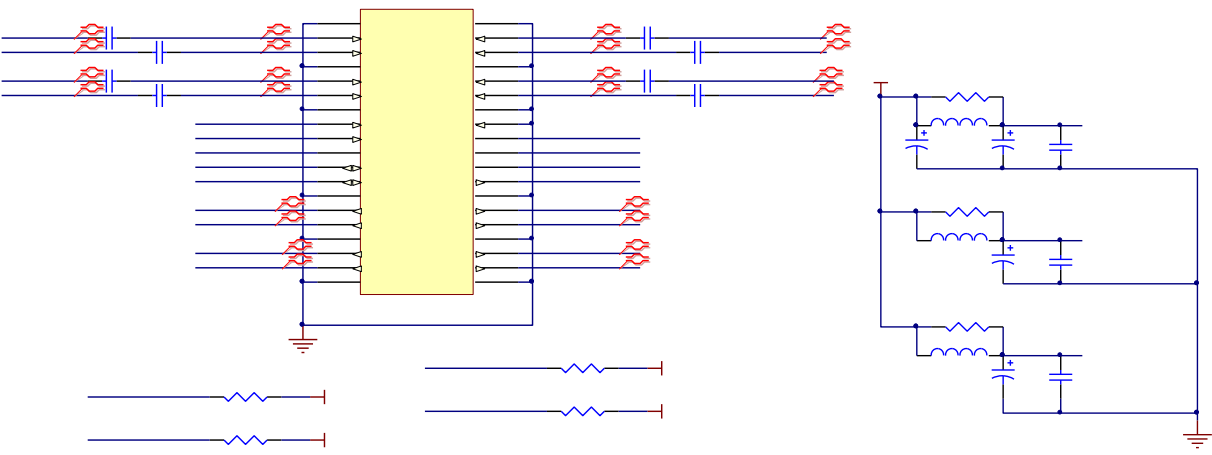
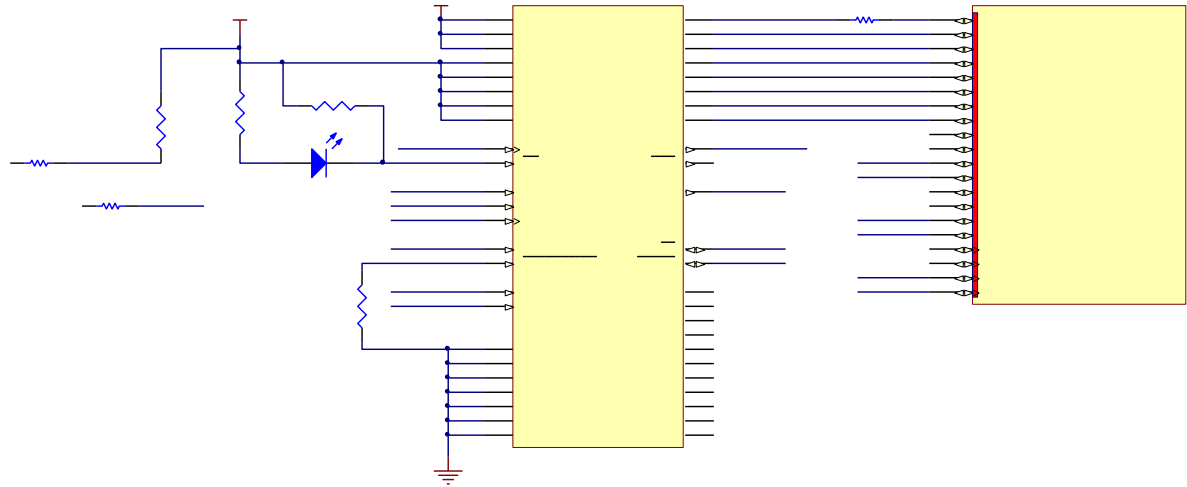
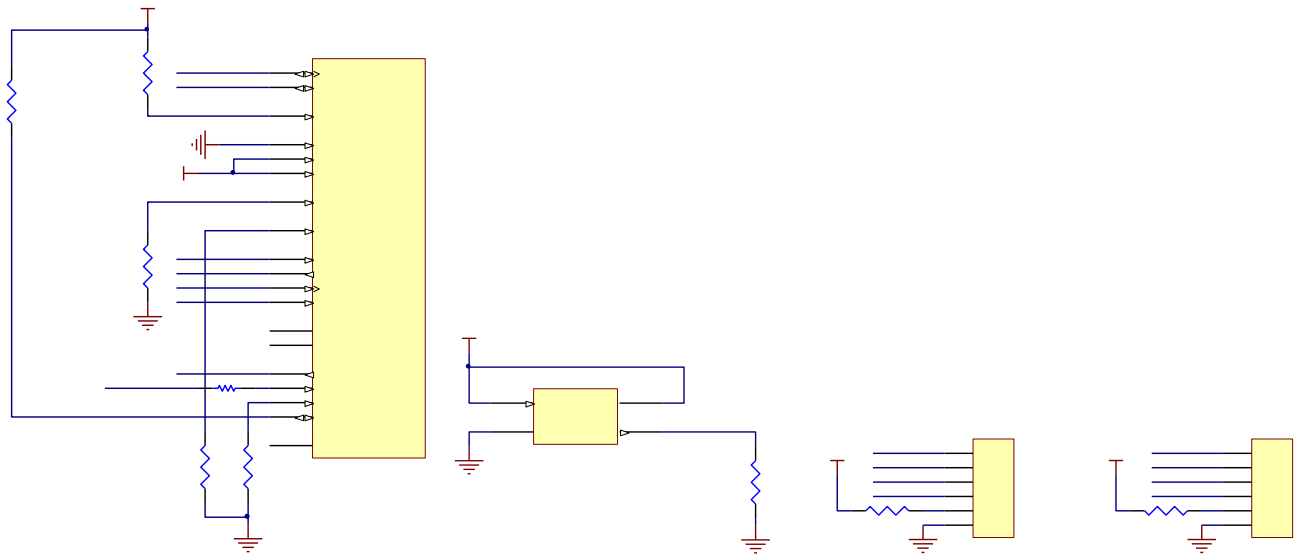
- Chris. (2009). Global Trigger Processor., (pp. 1-14).
- Chris. (2009). Hall\_D trigger layout., (pp. 20-25). Virginia.
- Collaboration, C. (2009). CLAS12 experiment. *Journal* , 1-25.
- Collaboration, G. (2009). GlueX experiment. *journal* , 1-20.
- Cuevas, C. (2008). Signal Distribution Module., (pp. 1-10).
- Ed. (2010). Trigger Supervisor Module., (pp. 1-19).
- experiments, C. (1990). CEBAF experiements. *journal* , 1-10.
- GU. (2010). Optical transceiver jitter measurement., (pp. 1-12).
- Raydo, B. (2008). Trigger Distribution board., (pp. 1-10).
- GU, (2010). VME to JTAG implementation
- GU, (2010). VME to I2C implementation

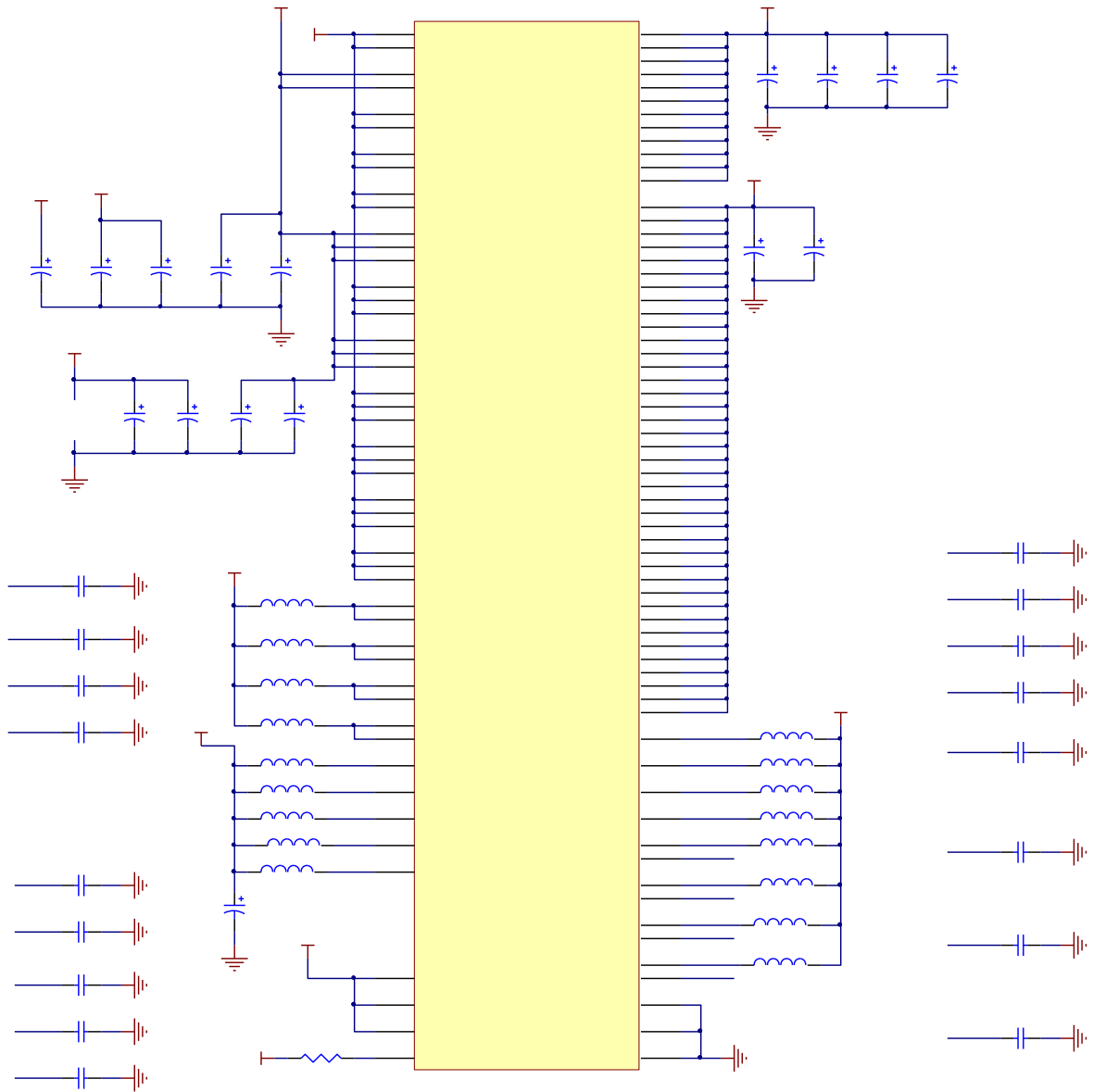
Appendix A: TID Schematics:

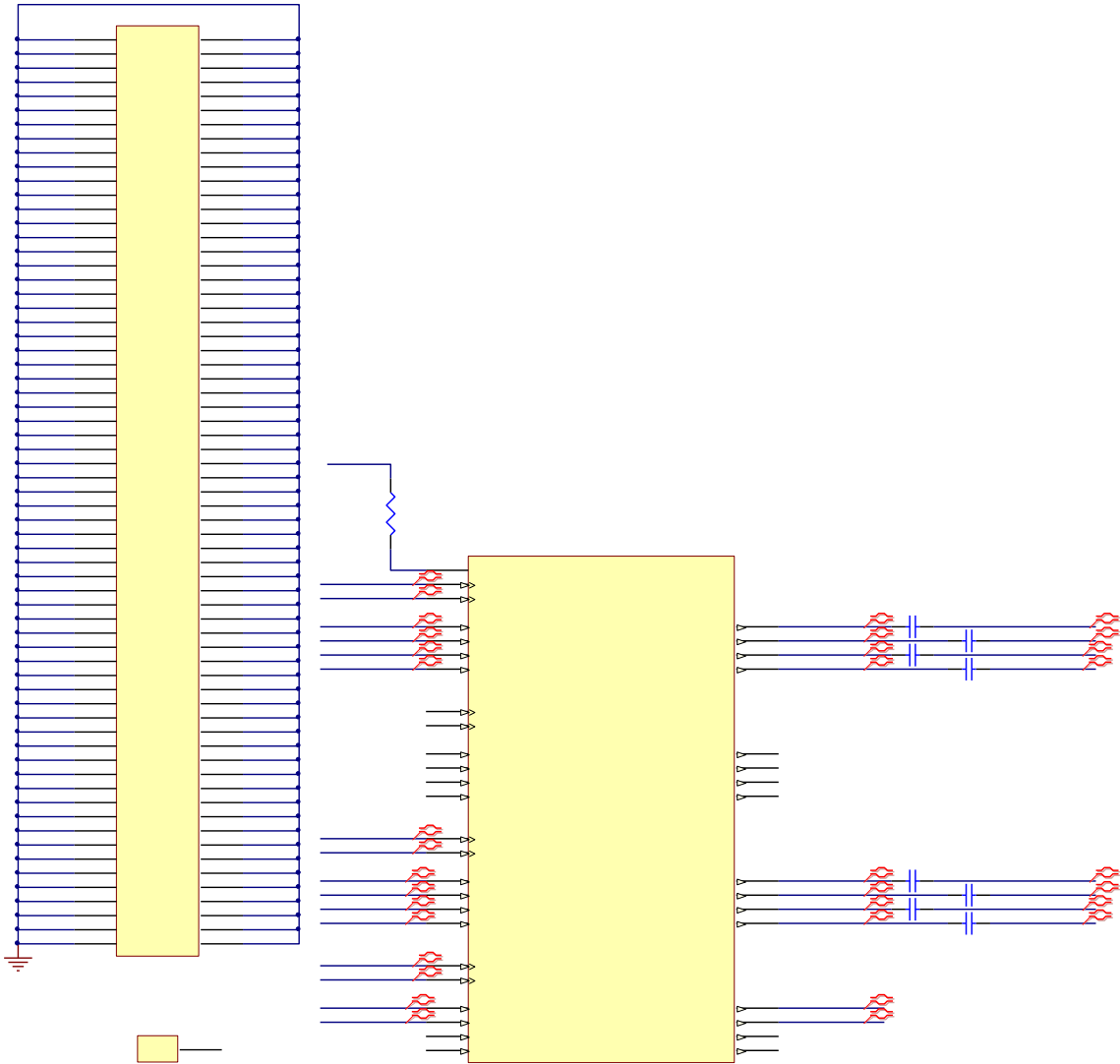


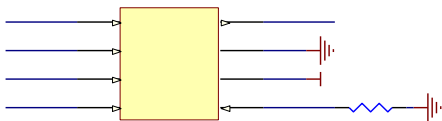
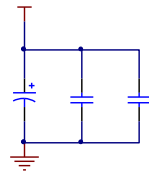
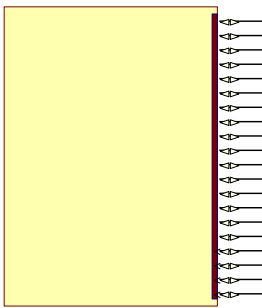
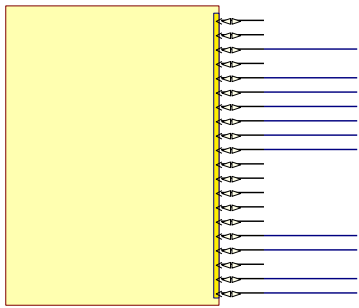
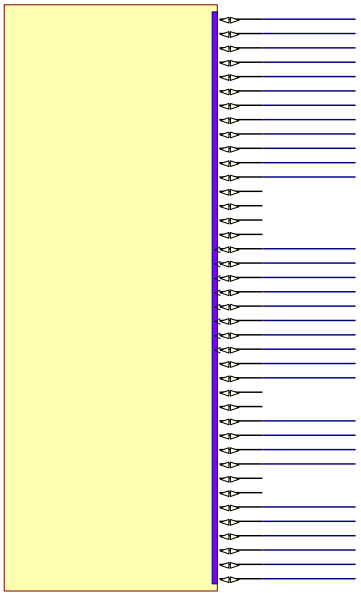
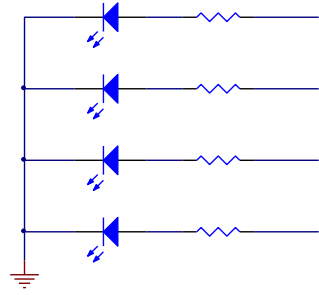
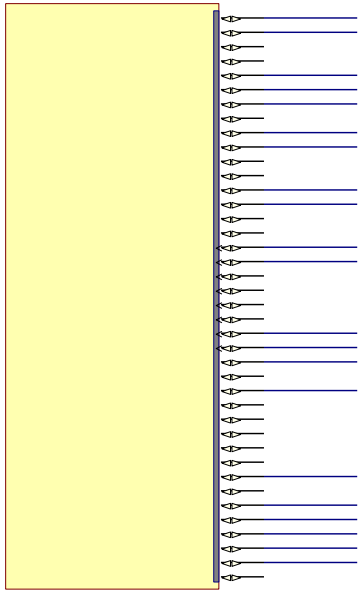
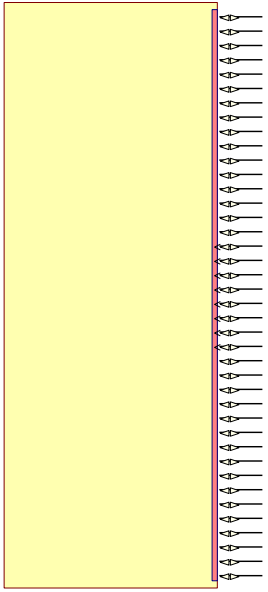




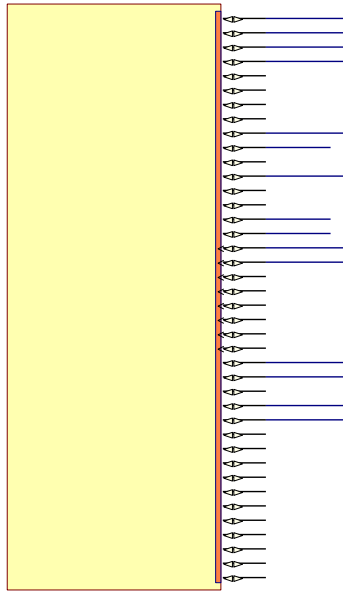
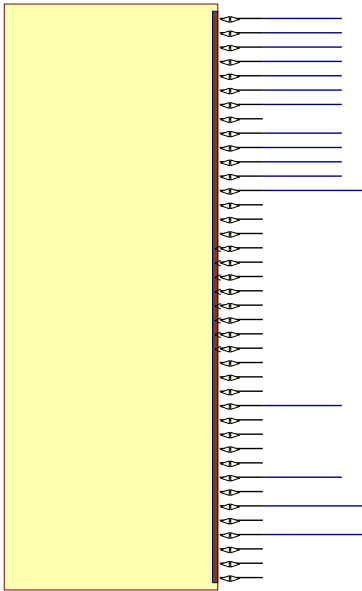
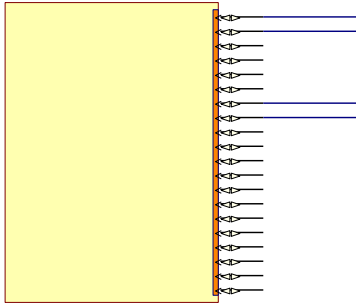
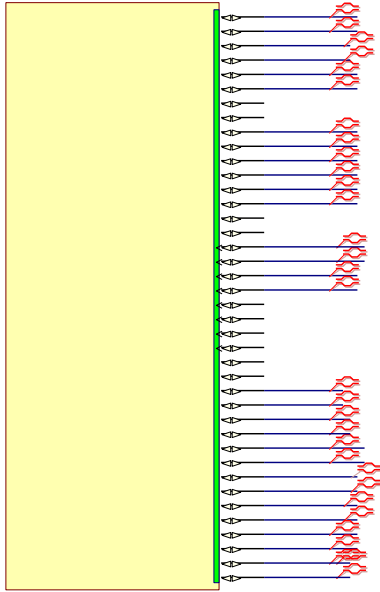
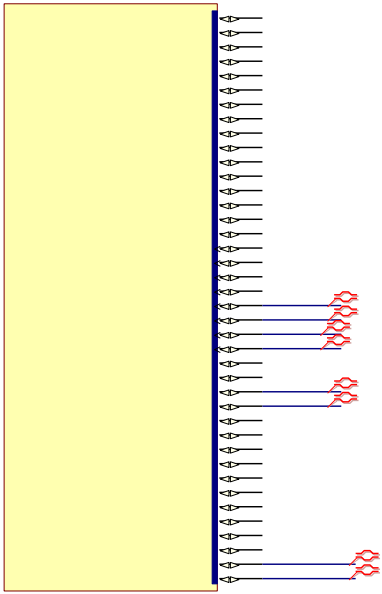




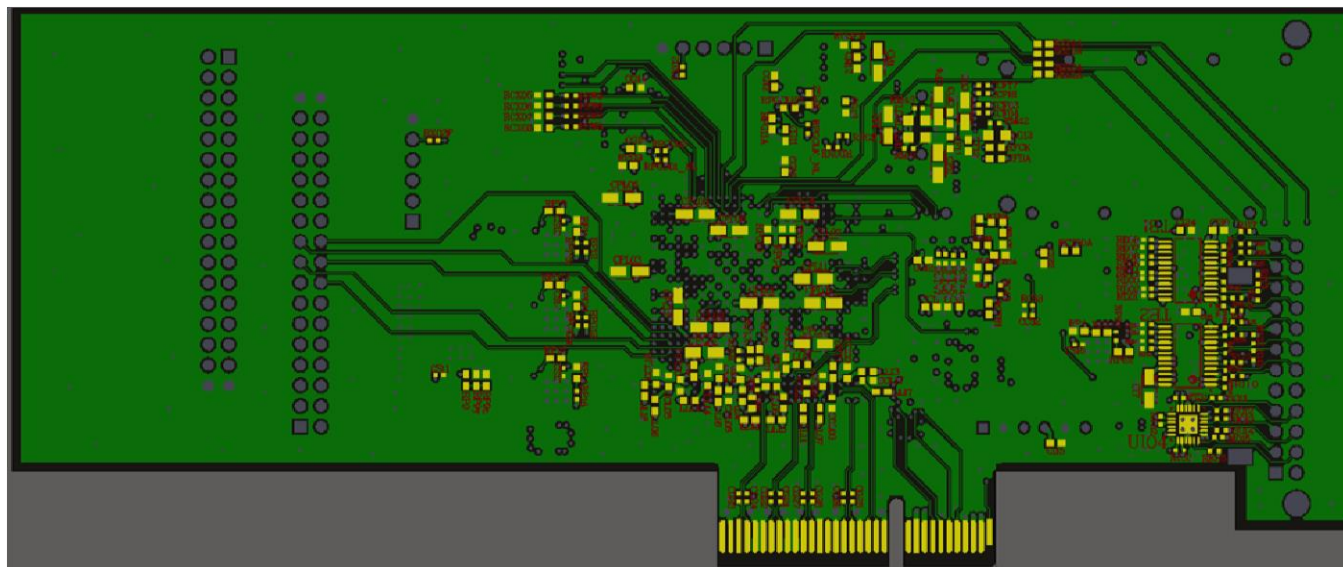
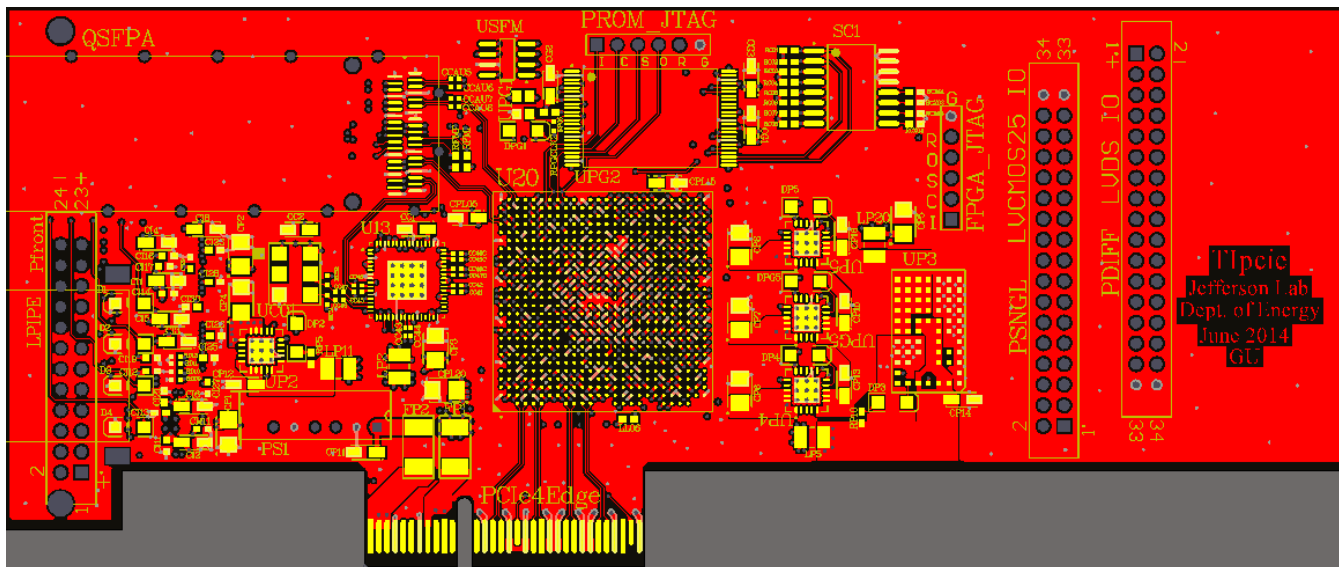








Appendix B: TID fabrication drawing:



## Appendix C: Bill of materials:

Comment	Description	Designator	Quantity
T520A	Solid Tantalum Capacitor,	CC1, CC2, CF1, CF2, CF3, CF4, CG1, CG2, CG3, CI1, CI2, CI3, CI4, CI5, CI6, CI7, CI8, CM1, CP11, CP12, CP13, CP14, CP15, CP16, CPL01, CPL02, CPL03, CPL04, CPL05, CPL06, CPL07, CPL08, CPL09, CPL10, CPL11, CPL12, CPL13, CPL14, CPL15	39
0.22uF	Ceramic Chip Capacitor - Standard	CC11, CC12, CC13, CC14, CC15, CCL01, CF11, CF12, CF13, CG11, CG12, CG13, CG14, CG15, CG16, CI11, CI12, CI13, CI14, CI15, CI16, CI17, CI18, CI19, CI20, CI21, CI22, CI23, CI24, CI25, CI26, CI27, CI28, CI29, CI30, CM11, CM12, CCL02, CCL03, CCL04, CCL05, CCL06, CCL07, CCL08, CCL09, CCL11, CCL12, CCL13, CCL14, CCL15, CCL16, CCL17, CCL18	53
0.01uF	Ceramic Chip Capacitor - Standard	CC32, CS11, CS12, CS13, CS14, CS15	6
0.1uF	Ceramic Chip Capacitor - Standard	CC41, CC42, CC43, CC44, CC45, CC45C, CC46, CC46C, CC47, CC47C, CC48, CC48C, CCAU5, CCAU6, CCAU7, CCAU8, CCF03, CCF04, CCF17, CCF18, CG21, CG22, CG23, CG24, CG25, CG26, CG27, CG28	28
T520B	Solid Tantalum Chip Capacitor, Standard T520 Series	CP1, CP2, CP3, CP4, CP5, CP6, CP7, CP8, CPL20	9
LED2	Typical RED GaAs LED	D1, D2, D3, D4, DP2, DP3, DP4, DP5, DPG1, DPG5	10
5.0A	FUSE 5A FAST BLOW NANO 2 SMD	FP1, FP2	2
Header 6	Header, 6-Pin, 0.1" pitch	FPGA_JTAG, PROM_JTAG	2
1.0uH	INDUCTOR 1.0UH 300MA 20% 0805	LG11, LG12, LG13	3
HF_0.5A	Inductor	LL01, LL02, LL03, LL04, LL05, LL06, LL07, LL08, LL09, LL11, LL12, LL13, LL14, LL15, LL16, LL17, LL18	17
HC_3A	Inductor	LP2, LP5, LP11, LP20	4
LIGHTPIPE		LPIPE	1
PCle4		PCle4Edge	1
09 18 134 9621	Flat Cable Connector (IDC), PCB Transition Connector, 2 Rows, Solder Pin, 34 Contacts	PDIFF, PSNGL	2
09 18 124 9621	Flat Cable Connector (IDC), PCB Transition Connector, 2 Rows, Solder Pin, 24 Contacts	Pfront	1
NMH1205SC		PS1	1
510	RES 510 OHM 1/16W 1% 0402 SMD	PSW5, PSW6, PSW7, PSW8, RDONE, RIO11, RIO12, RIO13, RIO14, RIO15, RIO16, RP12, RP12x, RP16, RPG12, RPG12x	16
QSFP	QSFP 38-pin connector	QSFPA	1
10K	RES 10K OHM 1/16W 1% 0402 SMD	R110, R111, R112, R113, R114, R115, R116, R117, R118, R119, R120, R121, R122, R123	14
3.24K	Resistor, chip 3.24K	RC01, RC02, RC03, RC04, RCT50A, RCTR1, RCTR2, RCTR3, RCX05, RCX06, RCX07, RCX08, RP5, RP9, RP9z, RP10, RPG2, RPG4, RPG5, RPG6, RPG9, RPG10, RPG11A, RPGCLK3, RUSFM	25
1.02K	Resistor, chip 1.02K	RC05, RC06, RC07, RC08, RCTR2A, RCTR3A, RCTR3B, RCX01, RCX02, RCX03, RCX04, RFCK, RFDA, RFMI, RFMP, RP4, RP6, RP6x, RP9y, RP11, RP13, RP14, RP15, RPG11, RPG13, RS21A, RS22A, RS23A, RS24A	29
50	RES 50 OHM 1/16W 1% 0402 SMD	RC31, RC32, RC33, RT5, RVPO, RX02, RX02F	7
100	RES 100 OHM 1/16W 1% 0402 SMD	RC43, RD01, RD02, RD03, RD04, RD05, RD06, RD07, RD08, RD09, RD10, RD11, RD12, RD13, RD14, RD15, RD16, RM41, RM42, RM43, RT31, RT32, RT33, RT34, RT35, RT41, RT42, RT43, RT44, RT47, RT48	31
150	RES 150 OHM 1/16W 1% 0402 SMD	RCT44, RCT45, RCT46, RCT47, RP6y, RPG8	6
0	Chip Resistor, 0 Ohm, 0402 Size, 0.063 W	RPGCLK2, RPGD01_NL, RPGD02	3

SW DIP-8	DIP Switch, 8 Position, SPST	SC1	1
max9602EUG	Differential discriminator	TB1, TB2	2
AD9510BCP	AD9510 clock	U13	1
XC5VLX30T-1FF665C	Xilinx Virtex-5 LXT Platform FPGA, 665-Ball FFPGA, Speed Grade 1, 360 User I/Os, Commercial Grade	U20	1
CCPD-034	CCPD-034, 250MHz low jitter	UC01	1
MC100EP91M	On Semiconductor, Any level positive to ECL translator	UIO4	1
TPS74401RGWT	IC LDO REG 3.0A W/SS 20-VQFN	UP2, UP4, UP5, UPG5	4
LTM4604EV	LTM4604AEV	UP3	1
kc2520-33MHz	Miniature Oscillator, 33MHz	UPG1	1
XCF32PVO48C	XCF00P Series, Platform Flash In-System Programmable Configuration 1.8V PROM, 48-Pin TSSOP, 32-Megabit, Commercial Grade	UPG2	1
AT45DB021D-SSH	Serial flash memory	USFM	1

## Appendix D: Glossory:

TID: Trigger Interface and Distribution module; a PCB design can be configured as TI, TD, TS or TM;

TI: Trigger Interface module; It seats in payload slot#18 in front end crates, interfaces the trigger and the DAQ system; It is one stuffing variation of the TID.

Tlpcie: Trigger Interface with PCI express x4 format.

TD: Trigger Distribution module; It seats in payload slot#1-16 in the global trigger distribution and fans out the TRIGGER/CLOCK/SYNC to eight TIs; it is one stuffing variation of the TID.

TS: Trigger Supervisor; It seats in payload#18 in the global trigger distribution crate; It is the interface between DAQ and trigger system; A simplified (pre-prototype) TS can be stuffed from a TID;

TM: TID Master. It is used in the subsystem test or commissioning setup; It generates TRG/CLK/SYNC as a TS, sends TRG/CLK/SYNC to P0 and P2 like a TI, and fans out TRG/CLK/SYNC through fiber to other TI like a TD.

SD: Signal Distribution module; It fans out TRG/CLK/SYNC from payload slot#18 to payload slots#1-16; It has clock jitter cleanup capability.

GTP: Global Trigger Processor module.

CTP: Crate Trigger Processor module.

DAQ: Data Acquisition.

ROC: Readout Controller; A VME CPU module used to readout the front end data through VME bus.

VXS: VME Switched Serial; A VME extension with dual-star serial switch slots.

MGT: Multiple Gbps Transceiver; A builtin transceiver module in Xilinx FPGA. In XC5VLX30T FPGA, it supports up to 3.125 Gbps.

## Appendix E: Tlpcie data format:

The TID data is formatted in blocks of events. Each Trigger\_1 is one event. A block of data contains a predefined number ( block level, this number could be 1) of triggers. Each block has two block headers, one block trailer, possible filler words, and event data. The data format is summarized here:

```
Block headers
  Event#1 data
  Event#2 data
  .....
  Event#N data
Block trailer
  Filler words for 64-bit alignment
```

Block Header#1:

```
bit(31:27): 10000, block header indicator;
Bit(26:22): BoardID;
Bit(21:18): 0000, ID for TI board;
Bit(17:8): block number, lower ten bits;
Bit(7:0): block size (or block level, as set by 0x84 trigger command);
```

Block Header#2:

```
Bit(31:17): 1111,1111,0001,000X; or 0xFF1X;
Bit(16): TimeStamp, 1 if timestamp is available, 0 if not;
Bit(15:8): 0010,0000, or 0x20;
Bit(7:0): Block size;
```

Block Trailer#1:

```
Bit(31:27): 10001, block trailer indicator;
Bit(26:22): BoardID;
Bit(21:0): Word count; does not include block header or trailer.
```

Filler words:

DataNotValid, read data when the data buffer is empty (no more data):

```
Bit(31:27): 11110;
Bit(26:22): BoardID
Bit(21:0): 00,0000,1011,1010,1101,0000, or 0x00BAD0;
```

Filler word #1 to make the word count an even number (64-bit aligned):

```
Bit(31:27): 1111,1;
Bit(26:22): BoardID;
Bit(21:0): block number;
```

Event data word1: (event header)

```
Bit(31:24): Trigger Type;
  0x00: filler events,
  0x01-0x40: Physics trigger; if the trigger is from TS, 0x01-0x20 indicates
one bit from the GTP, 0x21-0x40 indicates one bit from TS front panel.
  0xfc: multiple trigger inputs to TS;
  0xfd: VME trigger;
  0xfe: Random trigger,
  For TImaster bit(31:26) represents the TS#6-1 inputs;
Bit(23:16): 0000,0001, or 0x01;
Bit(15:0): Event wordcount; Event header is excluded from the count
```

Event data word2:

```
Bit(31:0): trigger number; counting from 1 to be consistent with wrap
around;
```

Event data word3: (enabled by data format register 0x18, bit#1)  
Bit(31:0): trigger timing; 4ns step

Event data word4: (enabled by data format register 0x18, bit#2)  
Bit(31:16): trigger number bit(47:32), to form 48 bit counter with word2;  
Bit(15:0): trigger timing bit(47:32), to form 48 bit counter with word3;

The data is written to DMA by Tlpcie through PCI express. The data are written in the DMA as a ring buffer with 4 Kbyte cells. Each readout data may use 1 or 2 cells, but one cell can have only one readout block. In each buffer cell, the data is further divided into subcells. Each subcell has MPS (for PCI express, the MPS can be 128 byte, 256 byte, ... 4 Kbyte) byte of data. Here is the data structure in one cell (in 32-bit word):

Status word:

Bit(31:28): free timer (11:8);

Bit(27:16): 64-bit word count of remaining data

Bit(15:8): free timer(7:0);

Bit(7:0): status of some internal signals, right now, they are: DataIn(34), DataIn(35), DataIn(70), DataIn(71), WriteEn, CountLoad, ReadyForRead, WriteBusy.

Data word #1: -- readout data word

.....

Data word #n : -- last word in the TLP packet. If the remaining data is more than MPS,  $n = (MPS/4)-2$ . To read more data, go to the next subcell. If the remaining data is less than the MPS, the Data word#n is the end of the readout data. To read more data, go to next cell (4 Kbyte) for more events.

.....

Dataword # (MPS/4-1) -- 0x00000000, filler word for the packet

The above ring buffer is for 3-header readout. For 4-header readout, there will be no status word. The software has to look for data word count to determine the end of the readout.

## **Appendix F: Document revision history:**

Feb. 2, 2015: First release, based on TI.docx;

Nov. 25, 2015: updated the 0x04, 0x104, 0x108, 0x138 registers

Dec. 8, 2015: updated the 0x34, 0x4c, 0x94, and 0xc0 registers

Jan. 21, 2016: updated the 0x1c and 0x38 registers.

May 4, 2016: updated the 0x28 register with bit(4) and bit(5).

May 31, 2016: Updated the register 0x138 and 0x100 (bit 21 and bit22).

June 2, 2016: Updated the BAR#1 for the optic transceiver I2C engine, and BAR#0 register 0x1C.

June 14, 2016: Updated the 0xEC register to enable the SyncResetRequest